



Backing visionary entrepreneurs

European Innovation Council
Data centre cooling: Research trends in efficient low-carbon solutions

Antonio Marco Pantaleo
Programme manager energy and green tech
Denver, 19 October 2023

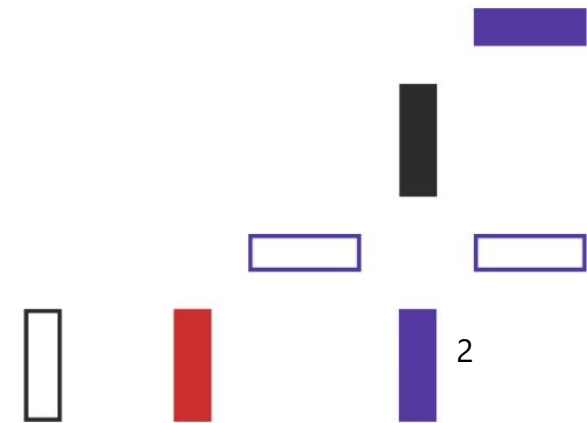
European
Innovation
Council





Contents

- Horizon Europe and the European Innovation Council
- The pathfinder challenge on clean cooling
- The problem of data centres cooling
- Emerging research and innovation trends



Horizon Europe Structure



HORIZON EUROPE

EURATOM

SPECIFIC PROGRAMME: EUROPEAN DEFENCE FUND
Exclusive focus on defence research & development

Research actions

Development actions

SPECIFIC PROGRAMME IMPLEMENTING HORIZON EUROPE & EIT*
Exclusive focus on civil applications

**Pillar I
EXCELLENT SCIENCE**

European Research Council

Marie Skłodowska-Curie

Research Infrastructures

**Pillar II
GLOBAL CHALLENGES & EUROPEAN INDUSTRIAL COMPETITIVENESS**

Clusters

- Health
- Culture, Creativity & Inclusive Society
- Civil Security for Society
- Digital, Industry & Space
- Climate, Energy & Mobility
- Food, Bioeconomy, Natural Resources, Agriculture & Environment

Joint Research Centre

**Pillar III
INNOVATIVE EUROPE**

European Innovation Council

European innovation ecosystems

European Institute of Innovation & Technology*

WIDENING PARTICIPATION AND STRENGTHENING THE EUROPEAN RESEARCH AREA

Widening participation & spreading excellence Reforming & Enhancing the European R&I system

Fusion

Fission

Joint Research Center

* The European Institute of Innovation & Technology (EIT) is not part of the Specific Programme



Pathfinder (TRL1-4)

- For consortia (open and challenge calls) and single entities (challenge call)
- Early stage research on breakthrough technologies
- Grants up to €3/4 million

Transition (TRL 4-6)

- For consortia and single entities
- Technology maturation from proof of concept to validation
- Business & market readiness
- Grants up to €2.5 million

Accelerator (TRL 6-9)

- For individual SMEs
- Development & scale up of deep-tech/ disruptive innovations by startups/ SMEs
- Blended finance (grants up to €2.5 million; equity investment up to €15 million or above)

With proactive management the EIC aims to maximize its support to success of the entrepreneurial journey

- Access to entrepreneurs
- Access to mentoring
- Access to ecosystems
- Access to partners, peers
- Access to trainings
- Access to workshops
- Access to expert advice
- Access to recruitment
- Access to industry

Business
Acceleration
Services

Proactive
Management

Programme
Managers

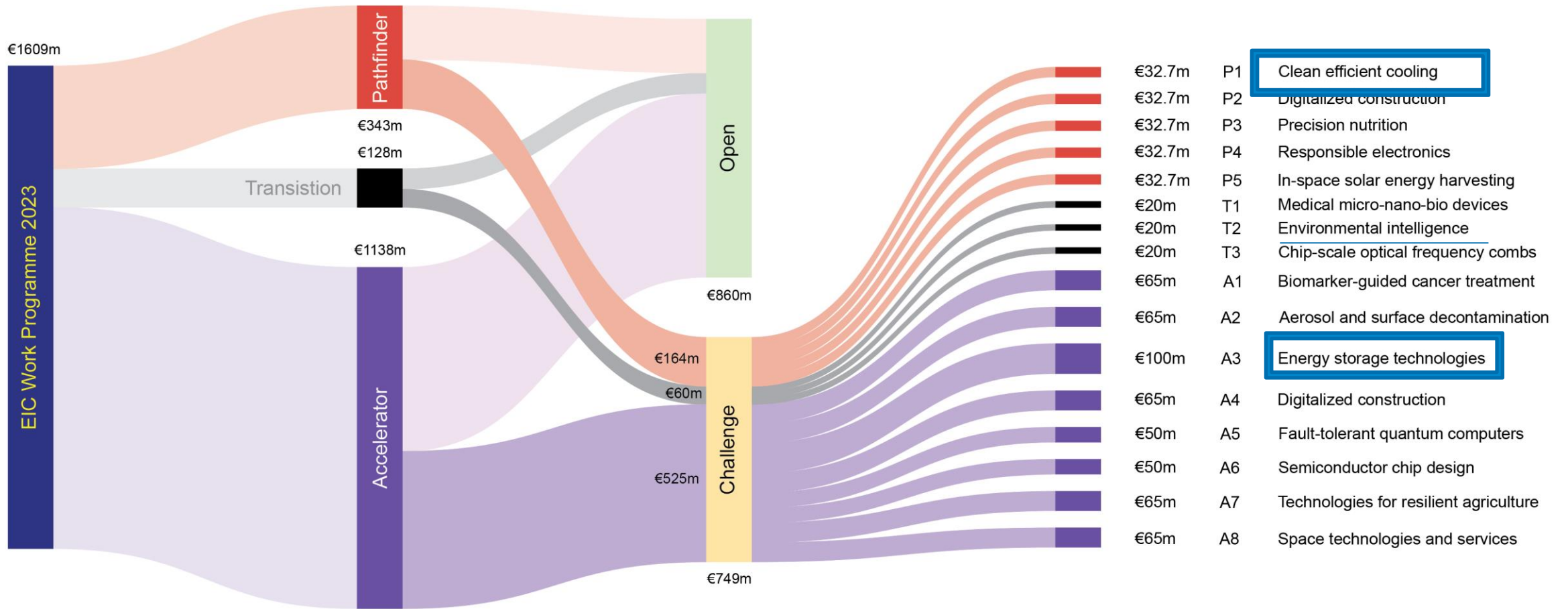
Project
Officers

- Health, Biotech
- MedTech
- SpaceTech
- Quantum, electronics
- Greentech materials
- Greentech
- AEC
- Agri-food
- Responsible electronics
- Bio-fuels, E-fuels



Challenges
Portfolios
Outreach

In 2023 EIC allocates ~€1.6bn to Open and Challenge calls by its Pathfinder, Transition, Accelerator programs



Priorities to identify the challenges in energy

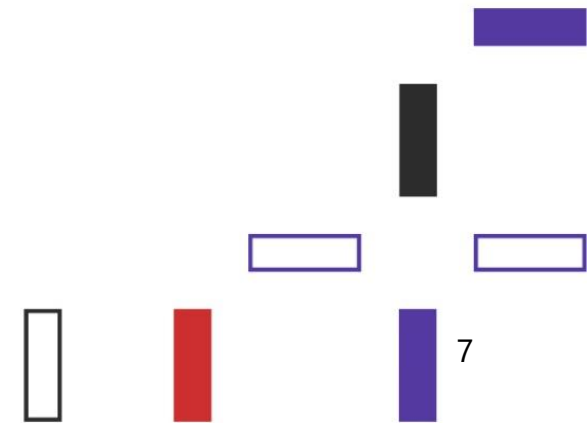


- **Energy demand** (saving and efficiency, storage, demand response)
- **Security of supply** (critical dependencies of fuels and material) and **Technological autonomy**
- **Sustainability**: defossilize the whole supply chains
- **Systems level thinking** (recycle and reuse, merit order of end uses, water/food/energy nexus, integration of technologies)

- Fit for 55%
- RepowerEU
- **Green deal industrial plan**
- **Net zero industry act**
- Critical raw materials act
- Chips act
- Electricity market design

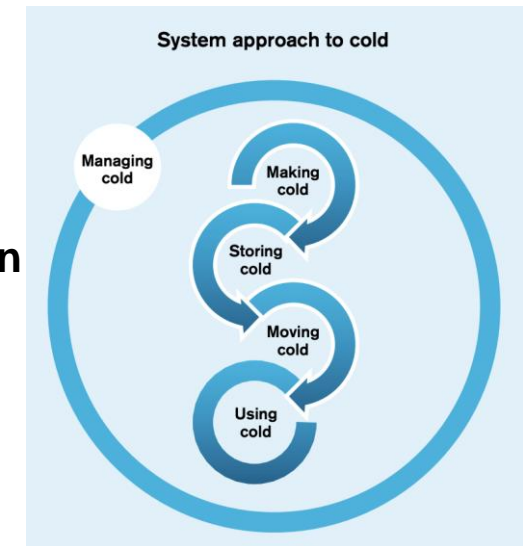
Focus of 2020-23:

- Green hydrogen generation
- Mid long duration energy storage
- CO2 and N management and valorization
- Clean cooling technologies



The challenge on clean cooling

- **Dirty process:** 10% of CO₂ emissions come from cooling (3 times more than aviation and shipping)
- **Fast increasing:** demand of air conditioning will cover 50% of global electricity demand by 2100
- **Data centres:** around **half of their energy consumption** goes on cooling (up to 100 GW by 2030)
- Current/future **energy carriers** (H₂, NH₃, CH₄) are small molecules : need cooling/ compression
- **Developing countries:** two million **vaccine** preventable deaths each year, and the **loss of 0.2 billion tonnes of food** (and 3.3 billion tonnes of CO₂ emissions, third biggest emitter after US and China).
- Clean cold requires a **fully integrated 'cold economy'**, with novel clean cold technologies, the integration of waste and under-exploited energy resources (i.e. wasted cold from LNG)



Need for:

- **transformational research** - displace existing technologies (i.e. functionalized PCM, laser cooling, reversible combustion etc)
- **Integration of renewable energy** for cooling (i.e. passive cooling, radiative and solar cooling, absorption and hybrid heat pumps)
- **Components:** new compression-expander mechanisms (scroll, electrochemical compression), mixed refrigerants, novel cycles configurations
- **store and move cold** (decoupling demand/generation) and system level integration
- **End uses:** management of cold consumption, diagnostics and soft fault detection

Scope/Specific objectives of the call



Potential broad areas of applications

- 1) **data centres**, electronics, batteries and superconductors
- 2) **built environment**, building health and comfort, interoperable urban energy systems
- 3) **food production** (i.e. vertical farming), processing, storage and refrigerated transport,
- 4) **cold energy carriers production**, transport and network integration (liquid H₂, LNG, ammonia)
- 5) chemical, metallurgical and **hard to abate industries**

Research and innovation needs:

- 1) net zero cooling technologies for industrial/residential sector (solar and geothermal, hybrid pumped heat and heat transformers, interoperability of district networks, etc);
- 2) ultra-energy efficient operations and logistics along the cold supply chain;
- 3) computational modelling, optimization and validation of heat transfer, working fluids, components;
- 4) unconventional refrigeration principles (i.e. thermoelectric, magnetocaloric, electrocaloric, elastomeric or barocaloric, photonic cooling).





Objectives and expected outcomes

New devices, processes, components and materials for cooling, to:

- reduce investment/operational costs
- increase efficiency, operational reliability and interoperability
- avoid the use of critical raw materials or harmful refrigerants and pursue circularity by design approaches

The proposals should refer the expected COP to the **max theoretical COP** of the inverse Carnot cycle and describe how the proposed solution can be **competitive with the state of art at the proposed operating range**. The solutions should aim to achieve **single stage temperature gradients higher than 5 °C** at a competitive COP.

Portfolio composition and proactive management

Preliminary portfolio composition approach:

Cooling generation

Cooling transport and storage

Operation, control and demand management

Portfolio activities

- Identification of **shared components** and potential **synergies**
- Definition of potential **common activities** and use of same **metrics** to compare technologies
- **Stakeholder** mapping and engagement with the innovation ecosystem,
- Development of common **exploitation plans** and communication activities
- Synergies with other **EU funding instruments**
- Policy, standards, regulatory **bottlenecks to innovation**



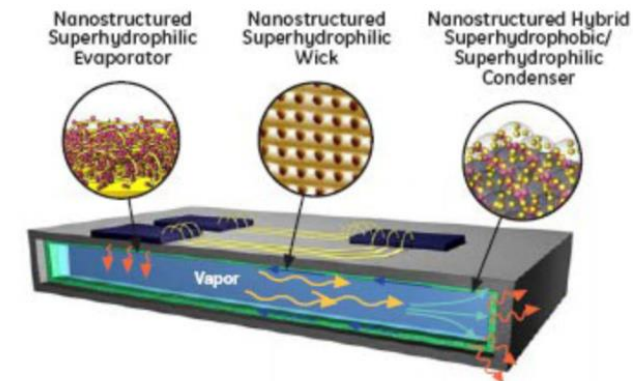
EIC pathfinder open: relevant research directions



- Dropwise condensation for heat exchange: Harmonic
- Viscoelastic liquid cooling for batteries: i-Bat
- Molecular storage and thermal fuels: Most and E-sim
- Magnetocaloric cooling with non critical materials: CocoMag
- 3D printing heat exchangers: Thermodust
- Deep geothermal for heat discharge: Deep-U

EIC accelerator: start ups

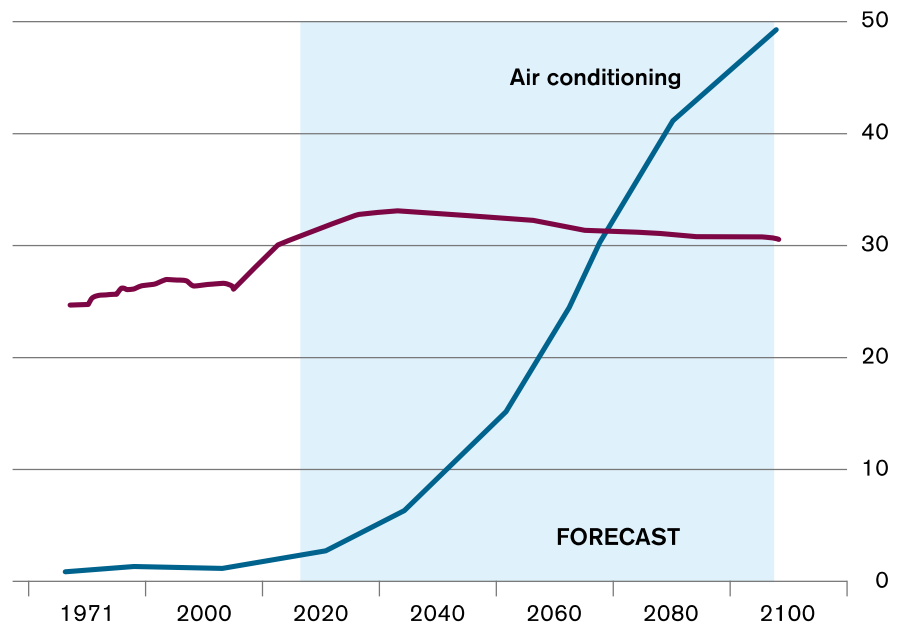
- Kiutra: solid state cryogenic cooling
- Magnotherm: use of high magnetic fields for cryogenic cooling
- Magnetocaloric Heating Cooling



A diagram of GE's advanced thermal material system. Leveraging unique surface engineered coatings that both repel and attract water, GE's system achieves twice the heat conducting properties of copper and can function under extreme forces of gravity. The improved heat properties will enable a wide range of better electronics applications, ranging from faster laptops and more advanced radar systems to better aviation and naval electronic control systems.

Cooling and global warming

Global energy demand for cooling could exceed that for heating from around 2070



Isaac & van Vuuren (2009) *Energy Policy*, 37, 507-521

It is crucial to consider energy demand for cooling for net-zero 2050

Greenhouse gases and their contribution to the global warming

GWP and Atmospheric Lifetime for Various Greenhouse Gases			
Greenhouse Gases	Chemical Formula	Global Warming Potential (GWP) for a 100-year Time Horizon	Lifetime (Years)
Carbon Dioxide	CO ₂	1	Variable
Methane	CH ₄	25	12
Nitrous Oxide	N ₂ O	289	114
HCFC-12	CHClF ₂	1,810	12
Tetrafluoroethane	CF ₄	7,390	50,000
CFC-12	CCl ₂ F ₂	10,900	100
Hexafluoroethane	C ₂ F ₆	12,200	10,000
Nitrogen Trifluoride	NF ₃	17,200	740
Sulphur Hexafluoride	SF ₆	22,800	3,200

Lashof & Ahuja (1990) *Nature*, 304, 529-531; www.ourworldindata.org

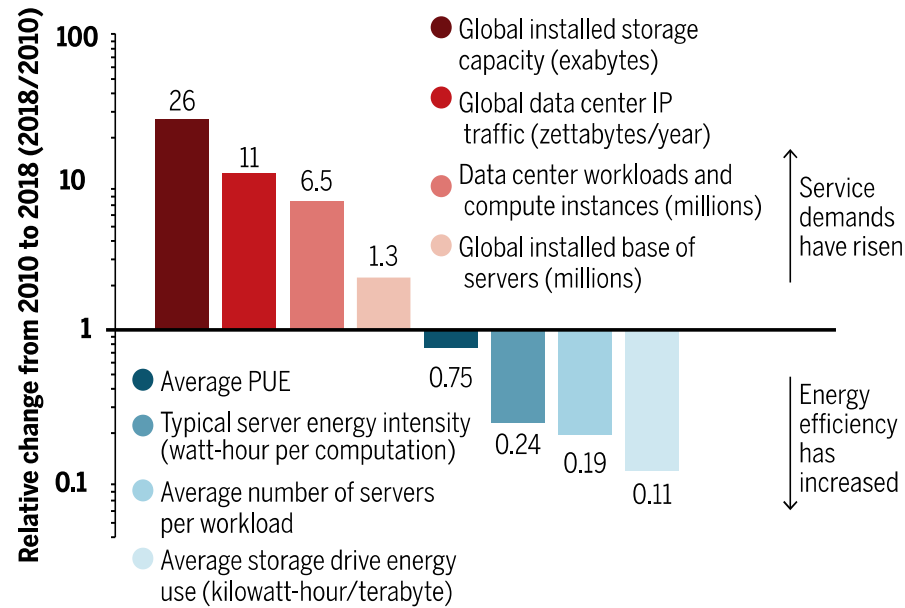
Refrigerants can have a significantly higher GWP than CO₂ over a 100-year horizon

ICT sector contribution to carbon emissions

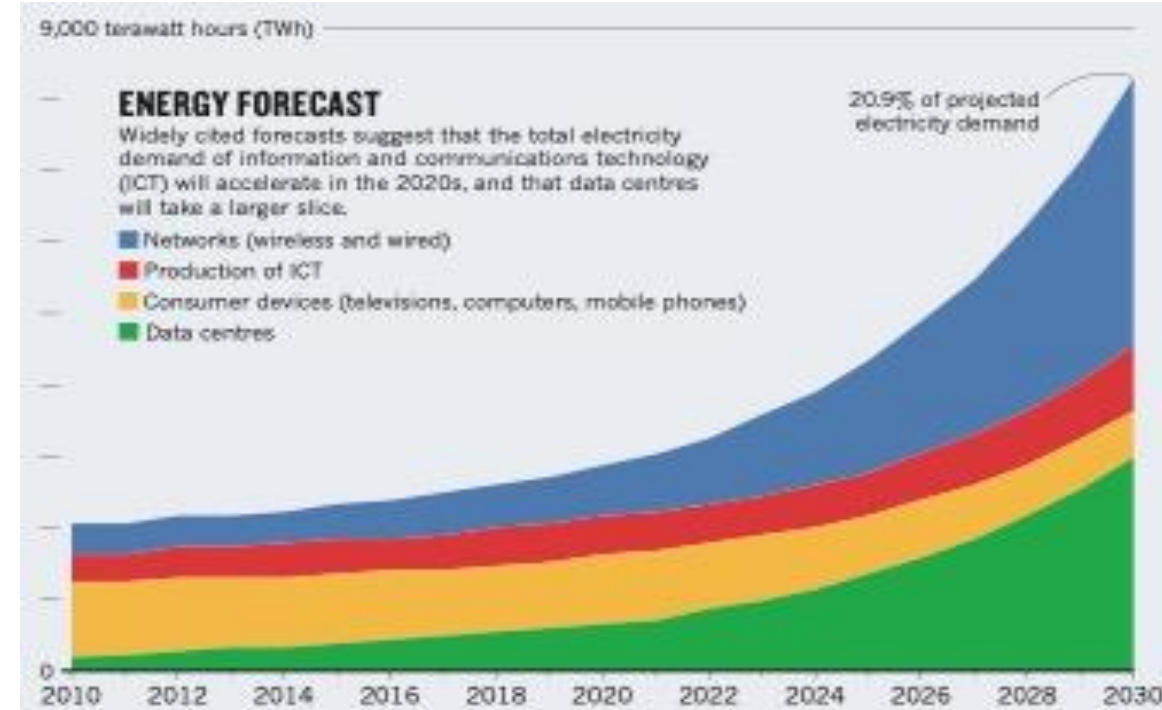


Increased telecommunication capabilities, intensified use of AI & Autonomous Vehicles drive the rapid acceleration and transfer of computing tasks to data centres

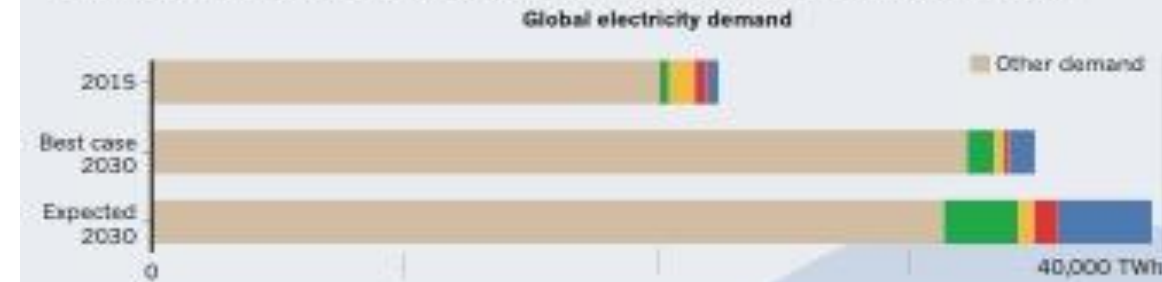
Trends in global data center energy-use drivers



PUE, power usage effectiveness; IP, internet protocol.



The chart above is an 'expected case' projection from Anders Andreas, a specialist in sustainable ICT. In his 'best case' scenario, ICT grows to only 8% of total electricity demand by 2030, rather than to 21%.



- Data centres consume some 300TWh electricity in 2020, ~1.5% of global electricity demand and ~1% of energy GHG emissions
- Demand projected to double in 2030 and tripled in 2040.
- Some 40% of the electrical consumption lost as heat

Masanet et al (2020) *Science*, 367, 984-986; Jones (2018) *Nature* 561, 163-166.

Demand is booming!

AND

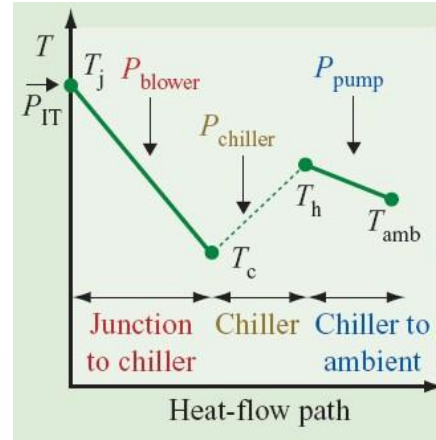
Cooling is about 40% of the energy demand

	2015	2022	Change
Internet users	3 billion	5.3 billion	+78%
Internet traffic	0.6 ZB	4.4 ZB	+600%
Data centre workloads	180 million	800 million	+340%
Data centre energy use (excluding crypto)	200 TWh	240-340 TWh	+20-70%
Crypto mining energy use	4 TWh	100-150 TWh	+2300-3500%
Data transmission network energy use	220 TWh	260-360 TWh	+18-64%

From 2017 to 2022: **average server rack density** up from 5 kW to 8-10 kW in US

Low Datacenter Efficiency

- Efficiency is 0.000'004%
- Volume used for compute is <1 ppm (part per million)

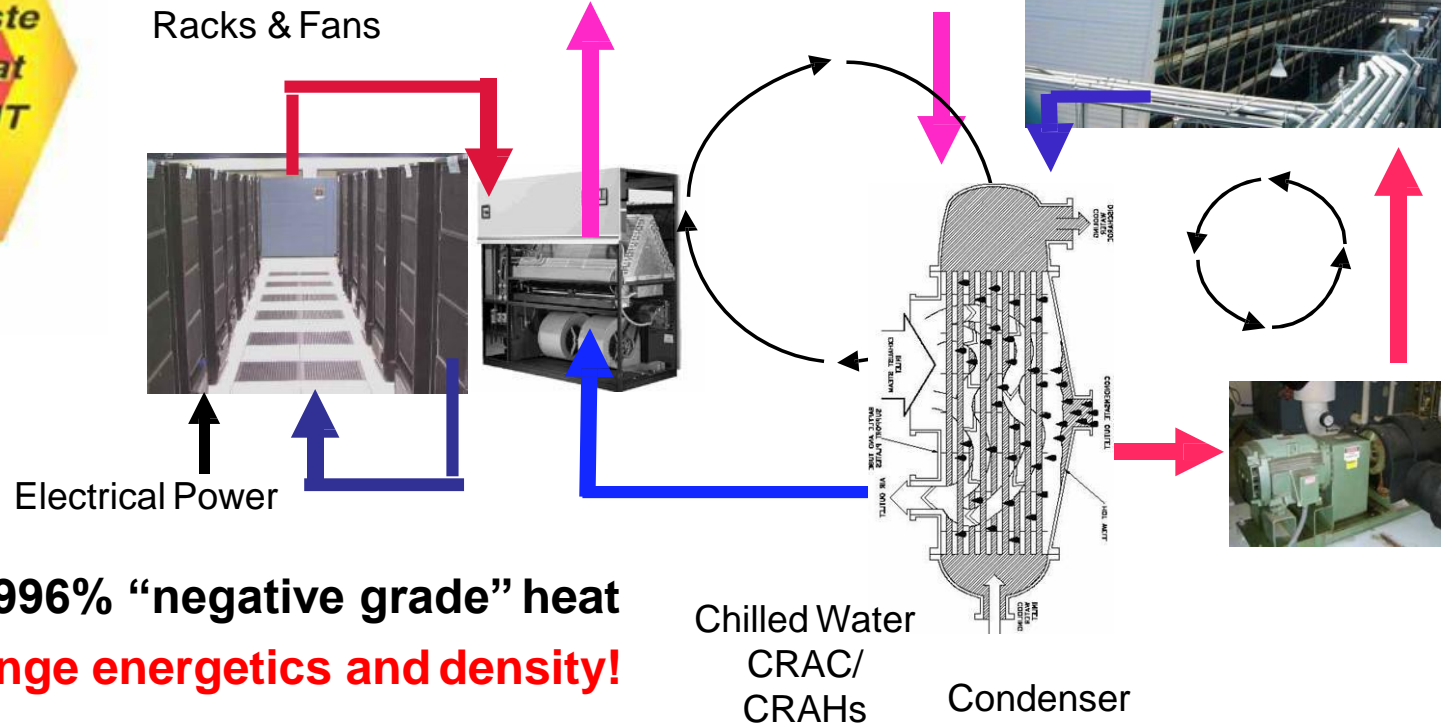


Brouillard, APC, 2006

- A computer is an inefficient “joule heater” “producing” 10-20°C “heat”.

The output is 0.000'004% ICT and 99.999'996% “negative grade” heat

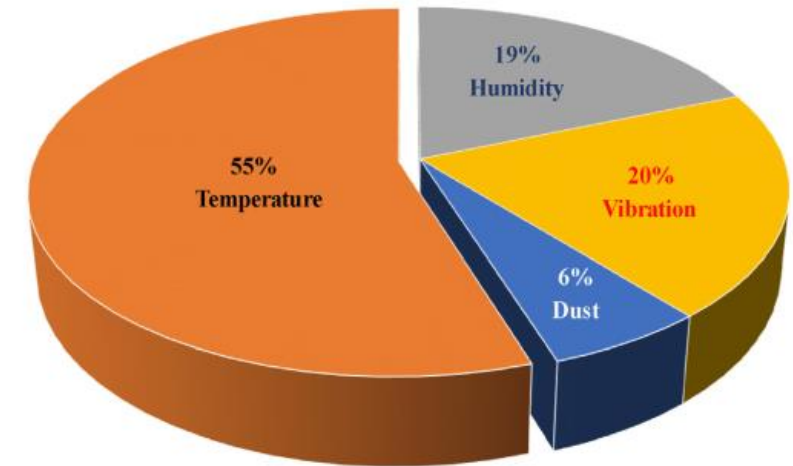
- **Consequence: We have a lot to do to change energetics and density!**



Data centre cooling: why and how?

- Increased **workload** increases heat dissipation and rack T
- High T causes failure and/or **low performance**
- High thermal power in **racks** difficult to dissipate
- Racks cooled with **air or heat pipes** not anymore the solution
- Liquid cooling: **high U factors** but dielectric materials durability risks and accessibility for maintenance/operations
- Streaming requirements: data centres **location constraints** (not possible anymore to optimize the location)

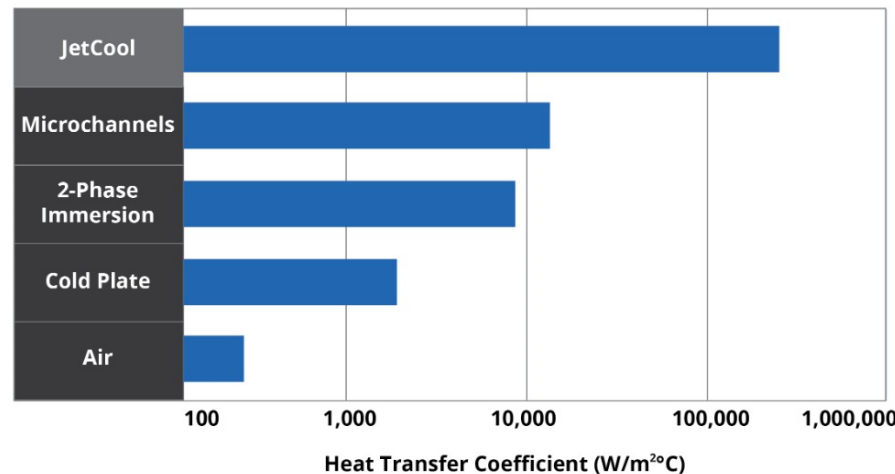
High T is the major cause of electronic failures AND **low performance**



The need
High workload and internal T of 40-50°C
Cool chip with $\Delta T = 20^\circ\text{C}$ instead of 75°C

Solution 1
High T of chips
Limit 85-100 °C

Solution 2
High U factors
up to 100 kW/m² C



■ Temperature ■ Humidity ■ Vibration

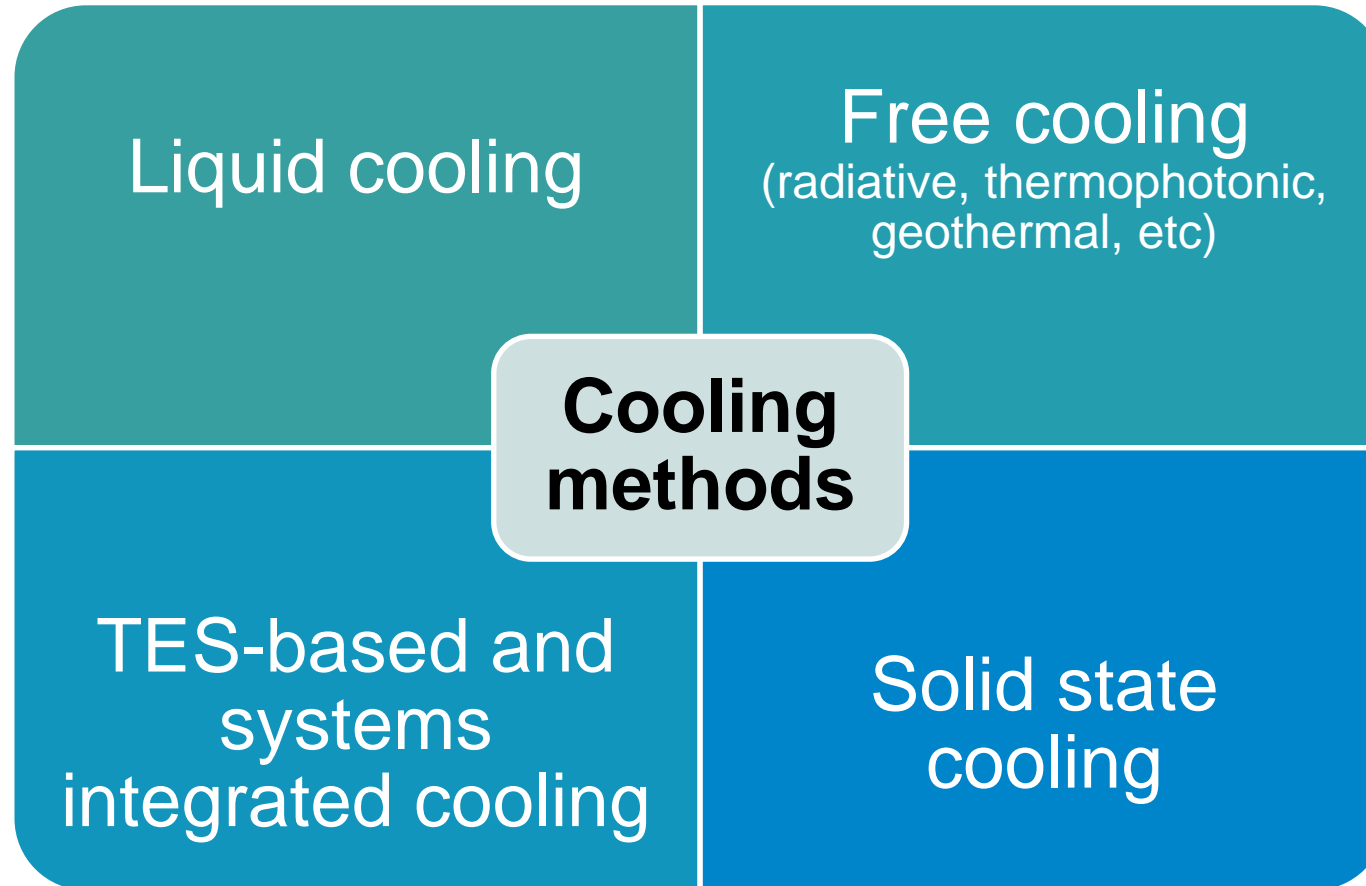
Ziqiang H, et al *Energy* 2021; 216: 119223.
<https://doi.org/10.1016/j.energy.2020.119223>.

Zhang Y, Ding Y et al. *Journal of Cleaner Production* 2022;334: 130280.

<https://doi.org/10.1016/j.jclepro.2021.130280>.

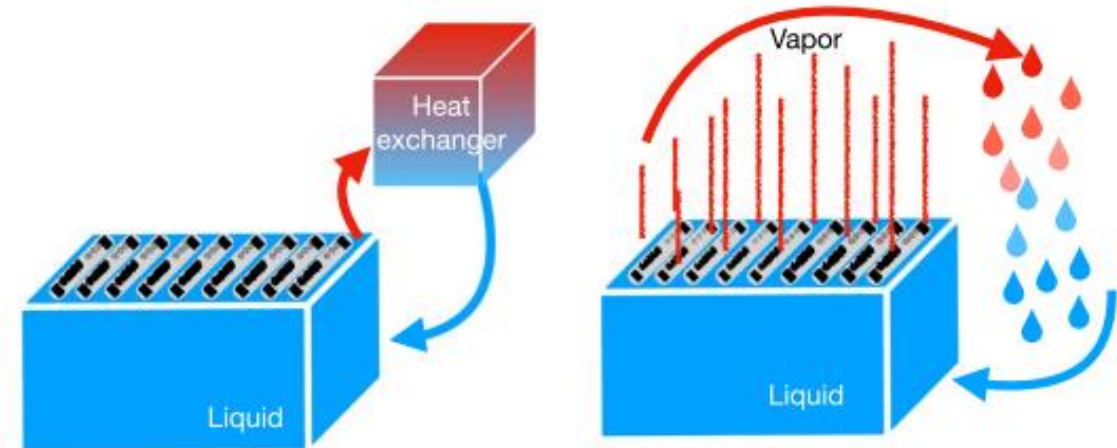


Cooling methods to save energy



Liquid cooling

- Liquid is transferred through servers
- Higher heat transfer coefficients
- Types:
 1. Cold plates connected to server
 2. Servers immersed in cooling liquid (one phase or two phases)



Zimmermann S, Meijer I, Tiwari MK, Paredes S, Michel B, Poulikakos D. 2012. Aquasar: a hot water cooled data center with direct energy reuse. *Energy* 2012; 43: 237–245. <https://doi.org/10.1016/j.energy.2012.04.037>.

Direct-to-Chip immersion Cooling



Technology description

Liquid cooling technique where a liquid coolant is delivered to a chip via flexible tubes to absorb heat with **direct contact to the chip**

Most relevant technical aspects

- Uses a heat transfer module (cold plate or heat sink) placed on the server board to directly cool the high-power rack components
- **Waterless (non-flammable dielectric fluid instead)**
- The two-phase liquid cooling uses a highly-efficient two-phase boiling and condensation process

Level of maturity

Not commonly used in Data Centres

Density supported

- **Around 175 kW/rack**
- Suitable for future generations of processors in the range of 200 Watts TDP and more

Performances

- **Heat transfer coefficient higher than 1,000 W/m²C**
- **PUE down to 1.08**

Benefits

- Reduced need for fans
- Able to support higher CPU and GPU densities
- Reduced space (less need for additional heat removal systems)
- Reduced downtime due to equipment overheating

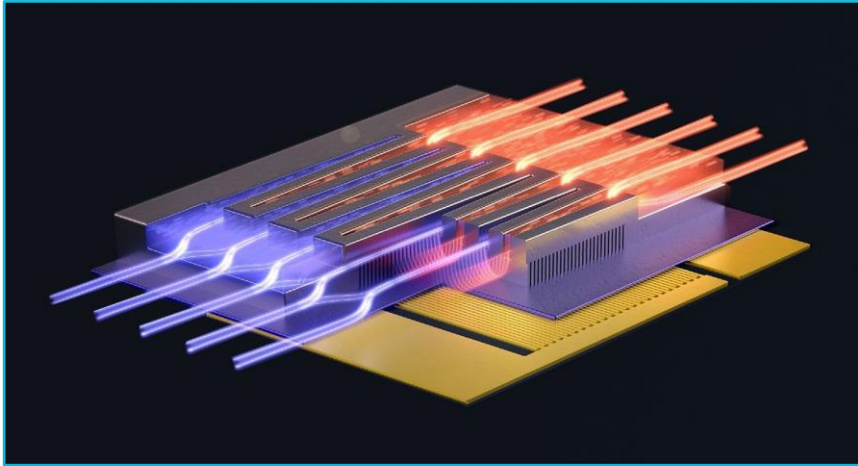
Downsides / Challenges

- Only a portion of server components are cooled with liquid, fans are still needed
- High-pressures / Water treatment

Key players



Microchannel liquid cooling



Technology description

An extension of direct-to-chip liquid cooling with the addition of **sealed metal plates** that allow to spread the heat generated in the device into small internal fluid channels

Most relevant technical aspects

- Provides cooling for a large surface area
- The small fluid channels facilitate interaction between the flowing coolant and the heated surface
- Channels may be skived, pin fin, or machined
- Metal plates target CPUs, GPUs, & memory modules
- Requires a thermal interface material to be applied

Level of maturity

All-aluminum microchannel heat exchanging products are now being widely used in the HVAC industry

Density supported

Same density as with a direct-to-chip cooling system

Performances

- Heat transfer coefficient around $10,000 \text{ W/m}^2\text{C}$
- 20% to 40% greater overall heat transfer performance

Benefits

- Less refrigerant charge
- Reduced material cost

Downsides / Challenges

- The thermal interface material can sometimes be a limiting thermal resistance layer as thermal design power reaches peak performance
- Keep pressure drops to a low level

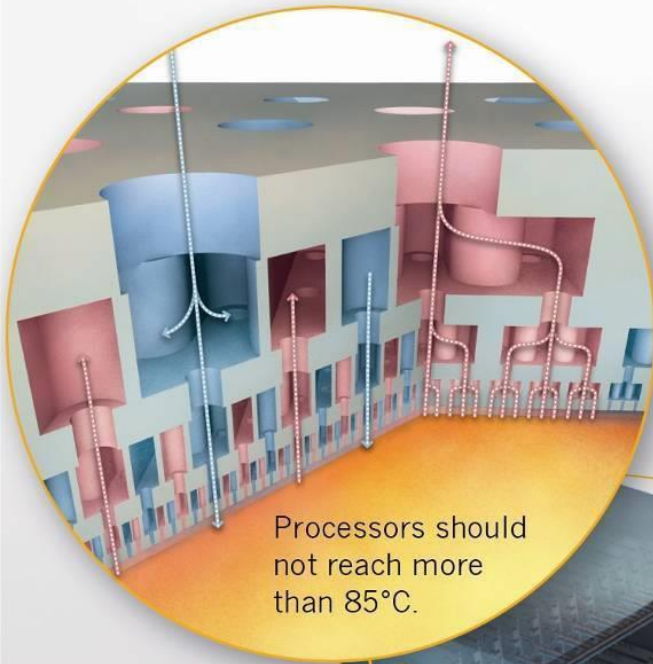
Key players

jetcool KALTRA



Hot-Water-Cooled Zero Emission Data-Center

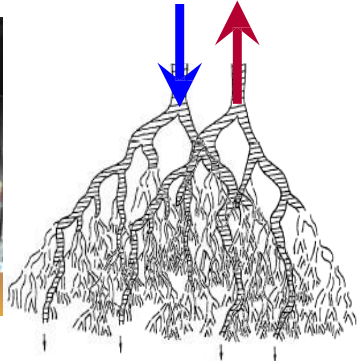
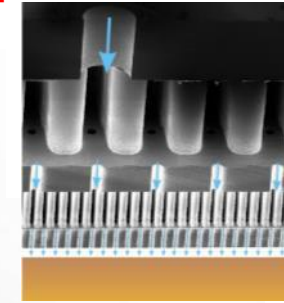
Hot-Water-Cooled Zero Emission Datacenters „Aquasar“



Micro-channel liquid coolers

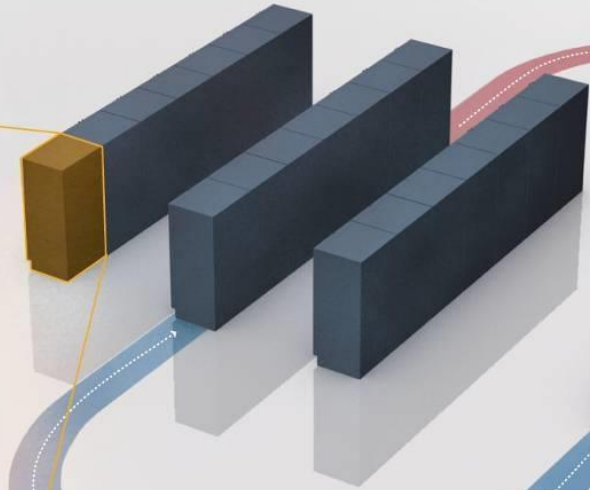
Heat exchanger

Water Pump



Processors should not reach more than 85°C.

CMOS 80°C



Heat exchanger

Direct „Waste“-Heat use e.g. heating

Water Out 65°C

Water In 60°C

Biological inspired:
Vascular systems optimized for low pressure transport

Courtesy IBM Corporation
Bruno Michel,
bmi@zurich.ibm.com

Two-phase immersion cooling



Technology description

Liquid cooling technique that involves the submerging of server electronics into a thermally conductive liquid bath relying on phase change as a form of heat extraction

Most relevant technical aspects

- As the dielectric fluid heats up to boiling point, heat is removed by latent heat transfer where liquid converts into vapour
- No longer a need for heat sinks
- Boiling point of 50° C

Level of maturity

- While fairly new, the technology is gaining some market traction
- As of April 2021, Microsoft is testing two-phase immersion cooling on a hyperscale **Azure Data Centre**

Density supported

Suitable for future generations of processors in the range of 200 Watts TDP and more

Performances

- Heat transfer coefficient around 10,000 W/m²C
- PUE down to 1.06

Benefits

- Immersion protects electronics from harsh amb. environm. & dust debris
- Reduced failure potential as no cooling fans are required
- Lessens the pumping infrastructure
- Reduced space / able to support hyperscale data-centres

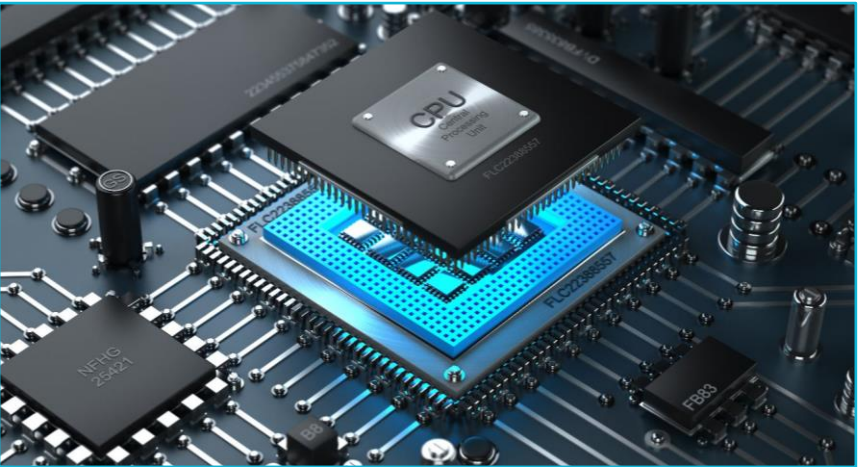
Downsides / Challenges

- Complex installation / hardware requires modifications to allow for long lifetime operation
- The dielectric fluid is expensive and must be kept in contamination-free containers

Key players



Microconvective liquid cooling



Technology description

Hotspot-targeted embedded liquid cooling that uses numerous **small fluid jets** within compact cooling modules

Most relevant technical aspects

- Directs fluid through an array of small **jetting nozzles** straight to the hot surface (perpendicular turbulent flow onto the device)
- Coolant can be any liquid including water, glycols, dielectrics, and refrigerants
- No use of thermal interface materials

Level of maturity

A relatively new technology

Density supported

Suitable for the densest compute profiles (more than 1,000 Watts TDP)

Performances

- **Heat transfer coef. > 100,000 W/m²C i.e. 10x greater than competing approaches** (microchannel liquid cooling, two-phase immersion)
- **PUE down to 1.02**
- technology reported to save up to 8% in data centre energy costs

Benefits

- Offers exceptional cooling performance for high-power electronics
- Minimizes thermal resistance by eliminating all thermal pastes and interface materials
- Enables faster compute times

Downsides / Challenges

No particular downsides or challenges reported (apart from accessibility and maintenance)

Key players



Immersion Cooling: Value Chain & Innovator Landscape

Software

Energy Efficiency Computing Technology



Digital Twins



Future Facilities



AI & ML



Hardware

Liquid & Immersion Cooling



Waste Heat



Renewable Power Generation



Courtesy Cleantech, 2023

Immersion Cooling: Investment / Corporate Activity

Venture Investments

2021

Undisclosed Seed
International expansion



CATHEXIS ventures

\$2M Seed
International expansion

ferveret

mundi ventures

\$34M Series A
International expansion



SK lubricants

\$28M Series C
Expand international footprint and global headcount



Undisclosed Series B
Accelerate R&D and commercialization manufacturing

liquidstack



\$3.8M pre-Series A
Phase change cooling technology development

incooling



Roll out the technology to all 16 of its datacenters



Corporate Activity / M&A



Deployment of cooling solution at Bellas Vistas



\$36M Growth Equity
Offer new modular integrated solutions for data centers

abc IMPACT



Awarded \$770K grant from U.S. DOE / ARPA-E COOLERCHIPS initiative to improve thermal performance of cold plates



liquidstack

Development of 12MW co-location data center in the U.S.



Acquired for \$270M to scale direct liquid cooling solution

KKR



Awarded \$1.7M and \$1.2M grants from U.S. DOE / ARPA-E COOLERCHIPS initiative to develop novel heat sink designs and microconvective cooling technology



Advancing the performance of single-phase immersion cooling fluids



Two-phase cooling

Two-phase change (liquid-vapour) to benefit from latent heat

No mechanical parts

Decoupling with racks for safe operations and maintenance

- **Heat-pipe-based cooling**

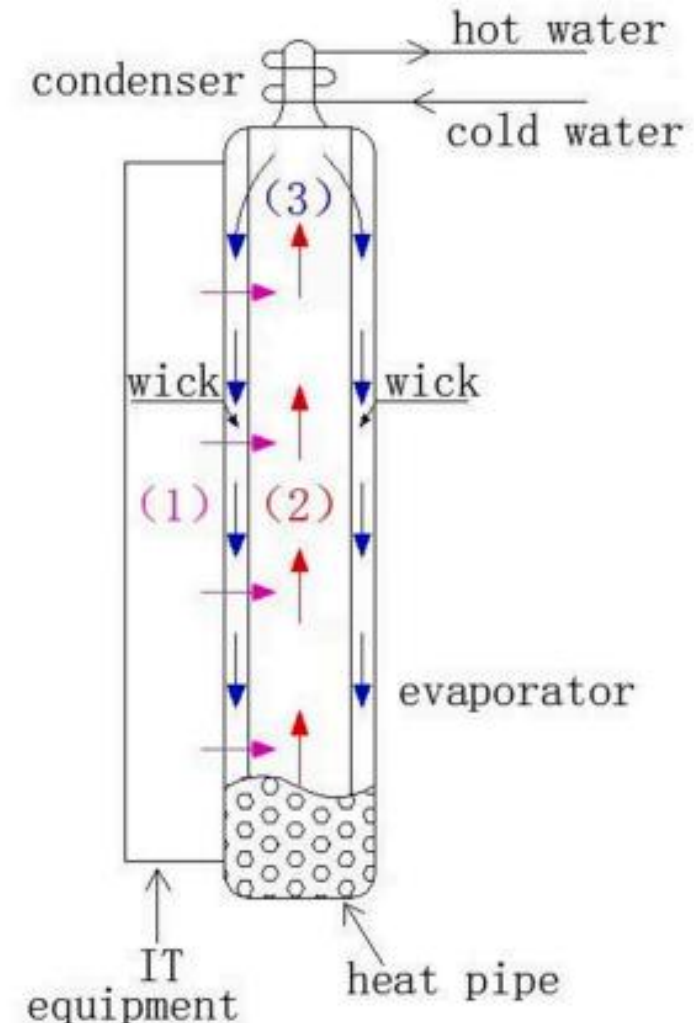
Heat pipes: tubes filled with structured material and a working fluid

Three sections: evaporation, adiabatic and condensation

Smaller temperature differences than standard CRAC systems

- **Thermosiphon-based cooling**

Gravity causes fluid to move from condenser to evaporator



Integration in District heating

- **High-performance chip-level cooling improves energy efficiency AND reduces carbon footprint**

- Cool chip with $\Delta T = 20^\circ\text{C}$ instead of 75°C
- **Save chiller energy:** Cool with $T > 60^\circ\text{C}$ hot water
- **Re-use:** Heat 700 homes with 10 MW datacenter

- **Need carbon footprint reduction**

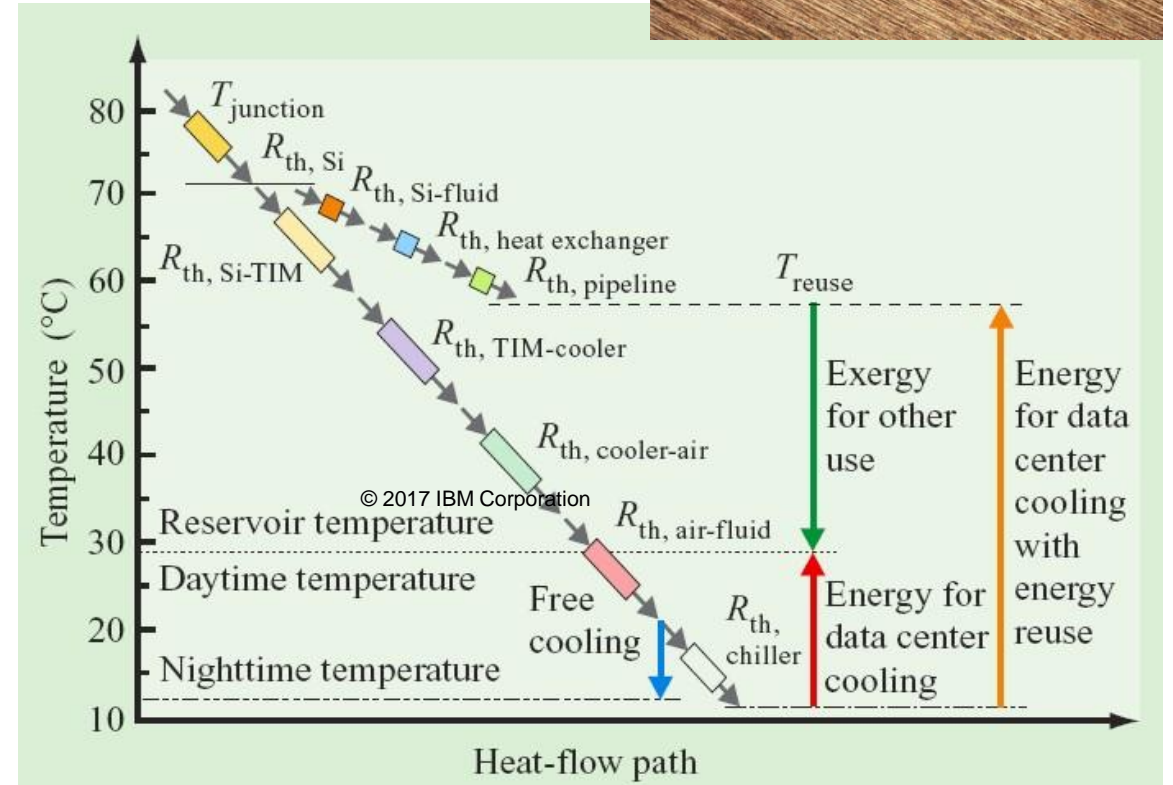
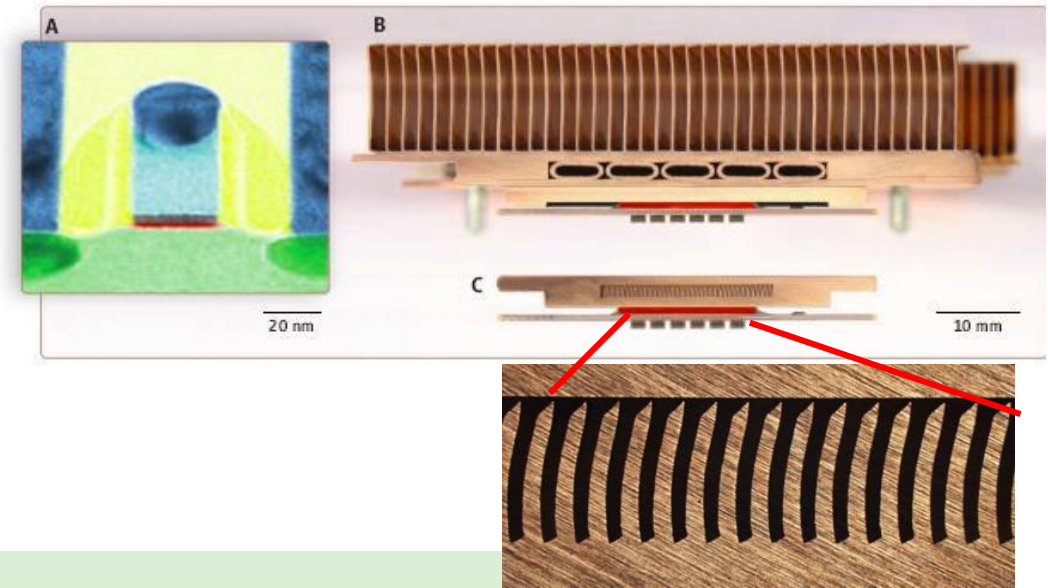
- Chillers use $\sim 50\%$ of datacenter energy
- Space heating $\sim 30\%$ of carbon footprint
- Chips can be used as heaters for DH

- **Zero-emission concept valuable in all climates**

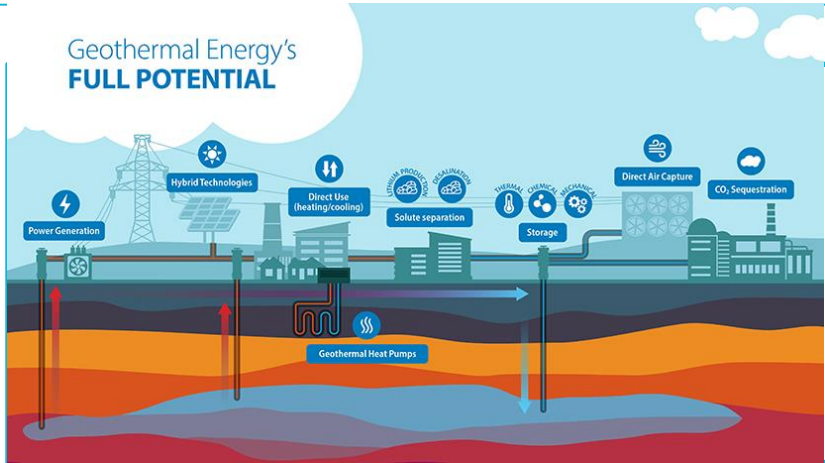
- Cold and moderate climates: **energy savings and energy re-use**
- Hot climates: Free cooling, desalination

- **Europe: 5000 district heating systems**

- Distribute 6% of total thermal demand
- Thermal energy from datacenters absorbed



Passive cooling: Geothermal resources



Technology description

- Ground-coupled cooling process that transfer heat from the IT environment into the relatively-colder soil (geo-exchange)
- Generation of cooling and power to serve energy demand for data-centres; good matching generation and demand.

Most relevant technical aspects

- **It maintains the traditional CRAC/CRAH units**
- the closed-loop piping system is filled with water or coolant that runs through vertical underground wells filled with a heat-transferring fill

Level of maturity

The technology has been around for quite some time, but is not yet widespread for data centres

Density supported

Same density as with a conventional chilled-water cooling system

Performance

25% to 50% less electricity usage than traditional HVAC systems

Benefits

- Lower operating costs
- Little maintenance
- Environm. friendly / quieter
- Does not depend on amb. temperature (improved reliability)
- Long equipment life (ground loop components can last over 50 years)

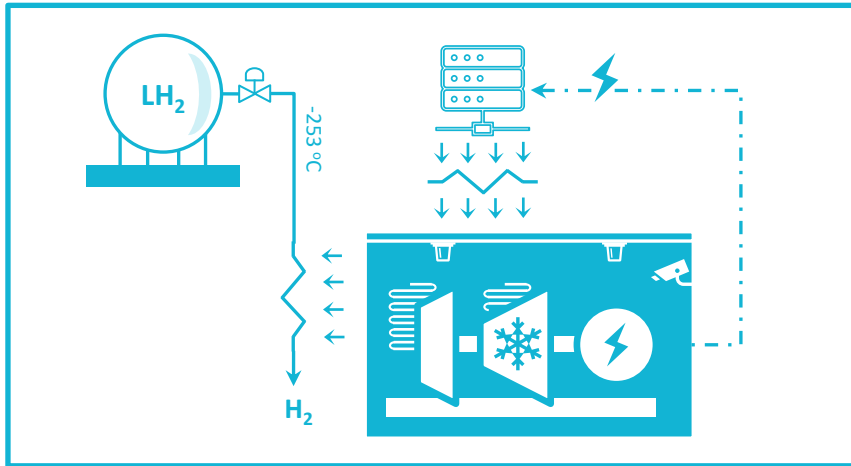
Downsides / Challenges

- High upfront installation costs
- May require significant landscape alterations

Key players



Systems integration: Cryogenic Cogeneration



Technology description

Thermodynamic process that uses the enthalpy difference between a low-boiling-point cryogen (LN₂ or LNG or LH₂) and the waste heat from the server racks to **generate power and cooling in customized turbines and heat exchangers at the same time.**

Most relevant technical aspects

- Utilization of the high-grade cold energy content in the LNG or LH₂ terminals for a continuous and stable cogeneration
- Solution also applicable for backup power generation with an LN₂-fueled open-cycle cryo-cogenerator
- It maintains the traditional CRAC/CRAH units and eliminates the use of chillers and cooling towers

Level of maturity

- TRL 3-4 (Lab-scale demo at TESLAB @NTU) – EU & US Patent
- Collab. agreement between Engie and NTU for the development of a 200-kW_e demo platform (2021)
- Keppel DC joining the demo phase (2023) for LH₂-driven syst.

Density supported

Same density as with a conventional chilled-water cooling system

Performance

- An LH₂-driven cryo-cogenerator coupled to a small-size terminal (1 k.TPD) would deliver up to 15 MW of power and 50 MW of cooling
- PUE around 1.1

Benefits

- Lower operating costs (free cold energy)
- Environm. friendly (zero emission)
- Does not depend on amb. temperature (improved reliability)
- Long life cycle (> 25 years)

Downsides / Challenges

- Requires proximity to LNG or LH₂ maritime terminals
- Requires high storage capacity if about LN₂-fueled cryo-cogen.

Key players



Integration of data centre, biogas fuel cell and DH

Demonstration site
LULEÅ (Sweden)

4 tonnes of biogas stored at 200 bar.

Covered trench with gas line, power and data.

Building with DH network

Fuel cell container with 9 fuel cells

Data centre container

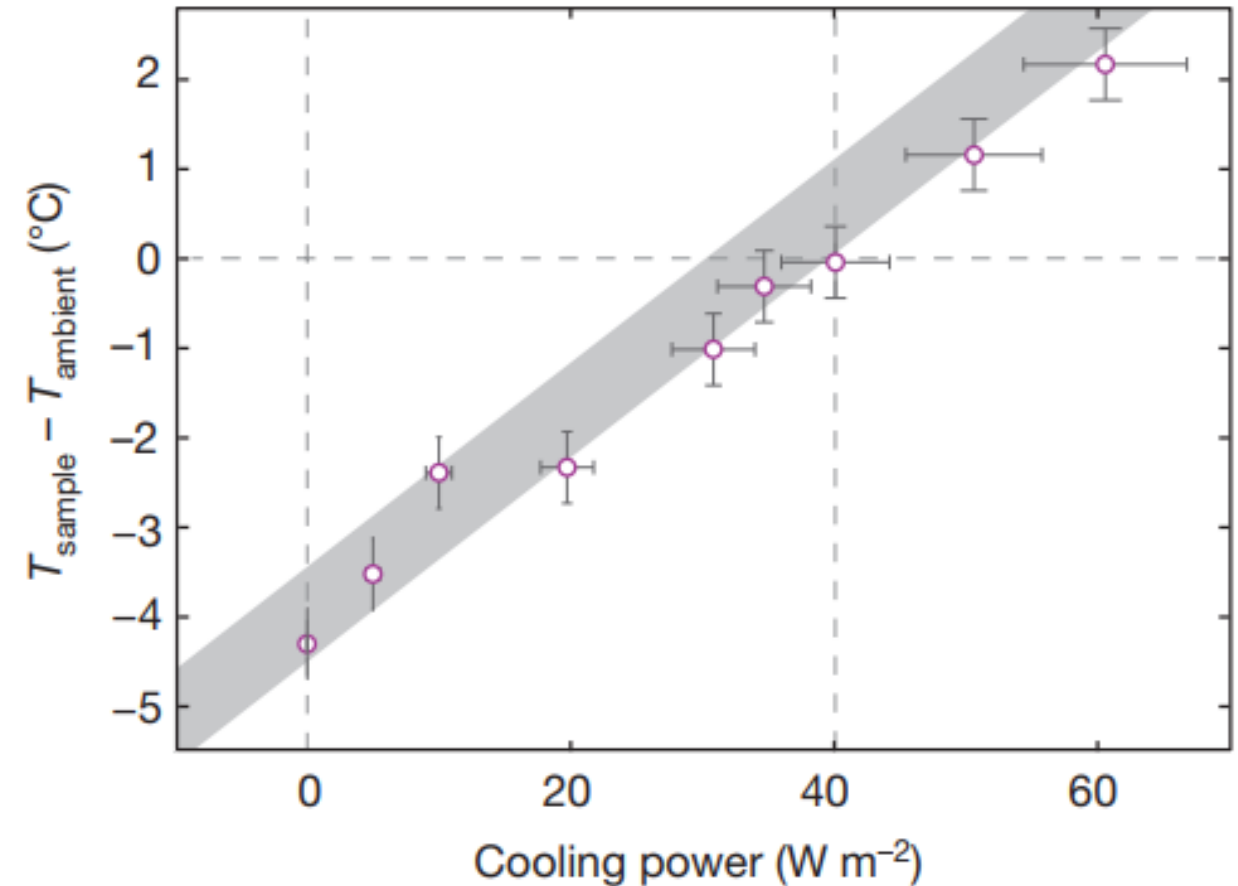


Passive cooling: radiative cooling below ambient temperature

- Photonic radiative cooler was found to reflect 97% of incident sunlight and cool 5 °C below ambient air temperature
- Could be directly integrated with chillers and HVAC systems

Raman AP, Anoma MA, Zhu L, Rephaeli E, Fan S. Passive radiative cooling below ambient air temperature under direct sunlight. *Nature* 2014; 515: 540-544.

<https://doi.org/10.1038/nature13883>.



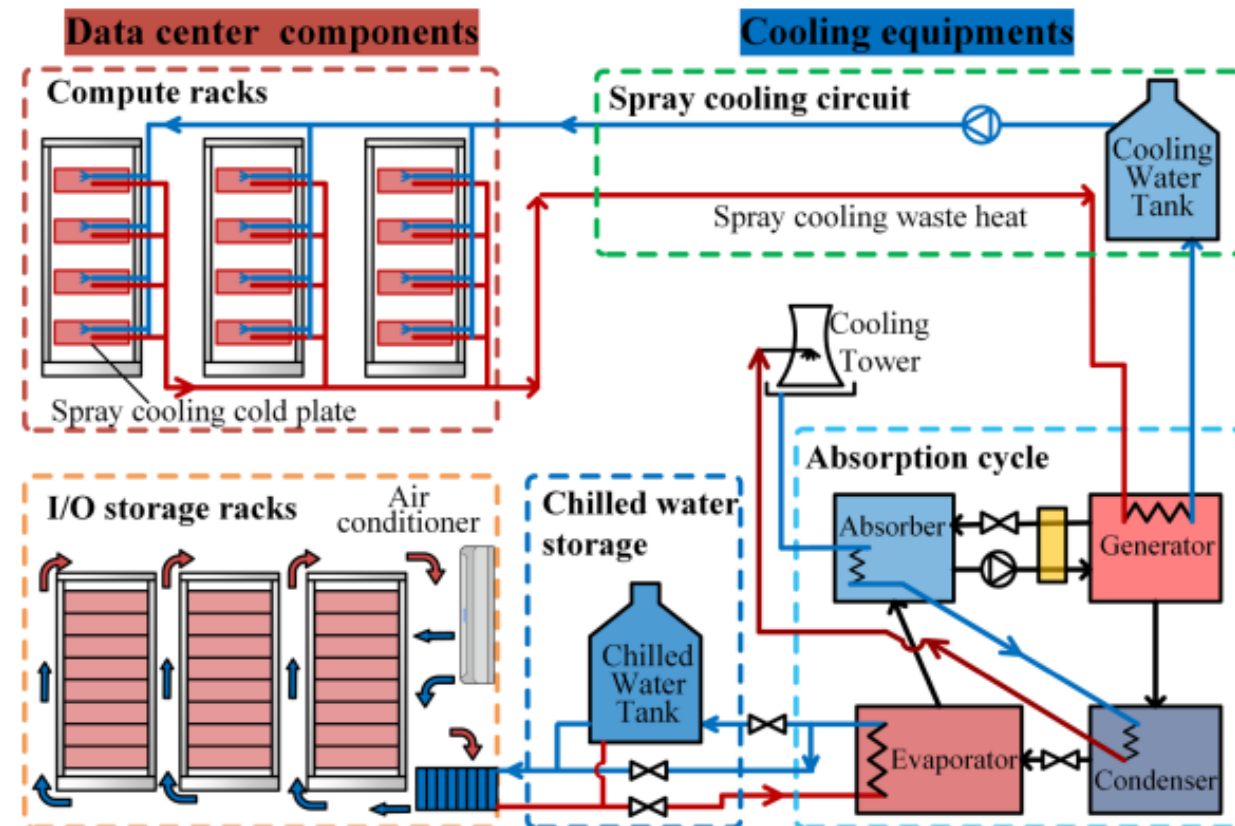
System integration: TES-based cooling

- Thermal Energy Storage: Decouples cooling requirements and electricity supply
- EIC pathfinder on duration storage 2022
- Used in conjunction with previous techniques

Examples:

Free cooling with lake water and cold water tank

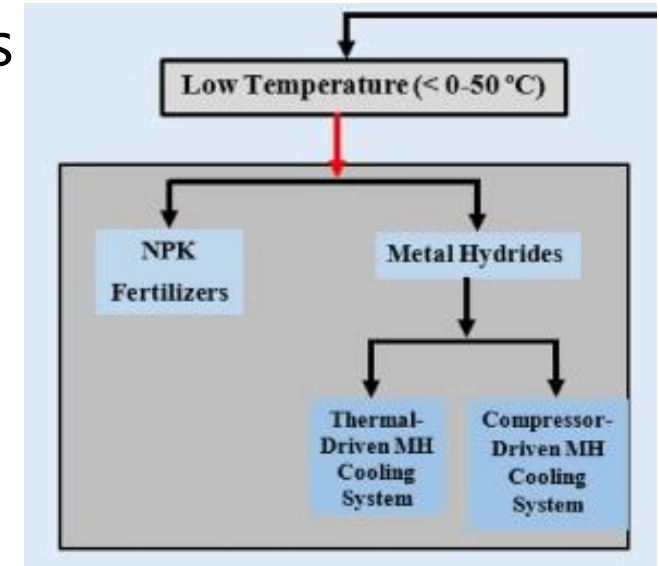
Liquid cooling with heat pipes and PCM
Spray cooling with cold water tank and absorption chiller



Thermochemical energy storage and absorption chillers coupled to cooling



- Chemical reaction-based energy storage system that receives thermal energy during the **endothermic** chemical reaction and releases it during the **exothermic** reaction
- Low-temperature (<math><0-50\text{ }^\circ\text{C}</math>) cooling applications are possible
- Could **waste heat from data centres** be used to drive thermochemical-energy based cold production or absorption chillers? **Data centres cool itself**
- **Direct rack-integration of adsorption** reduces installation and piping cost considerably and is a route to easy and fast implementation of energy and space savings.



Absorption chillers and data centres cooling

Examples in Germany: IT Cooling at Leibniz Data Center Munich

Facts & Figures

- LRZ is the largest German data center for supercomputing
- IT compute rack inlet temp.: 45-55°C
- Adsorption chiller cooling circuit temperature: 21°C
- Re-cooling circuit temp.: 25°C to 30 °C
- Avg. driving power (IT): 120kW, Avg. cooling power: 50kW (for storage)
- Adsorption chillers still installed separately.
- **First real size installation to prove this technology. Currently, no other adsorption chillers exist, which may be used in this application.**
- **Partners: IBM/Lenovo - Intel**

Courtesy of Sorption
technologies

Results

- 120 kW heat removed from computer
- 50 kW cold produced for storage units
- 9 kW electricity needed
- Upscaled to the entire data center this means that no compression chiller is necessary anymore:

The data center cools itself.

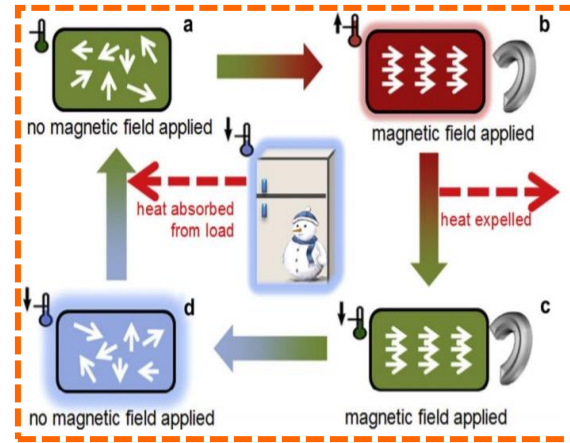


Solid-state systems for cold storage and use

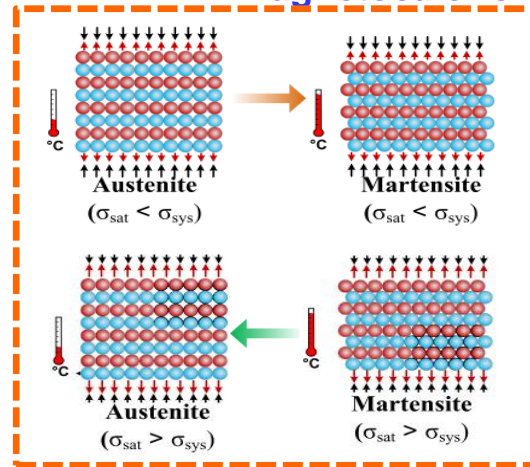
- Traditional refrigeration systems use gases or liquids
- **What about using solids?**
- Solid-state systems: a reversible **thermal change occurs in certain materials** when subjected to a time-varying magnetic field, strain or electric field
- When a barocaloric material is subjected to a pressure change, it undergoes a phase transition, from a solid to a liquid or vice versa
- During phase transition, the material either absorbs or releases heat



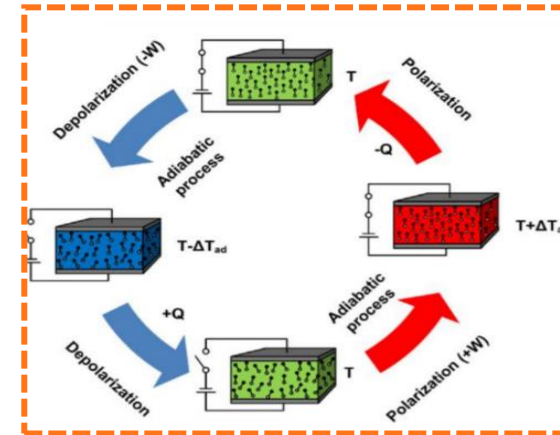
Solid-state cooling systems



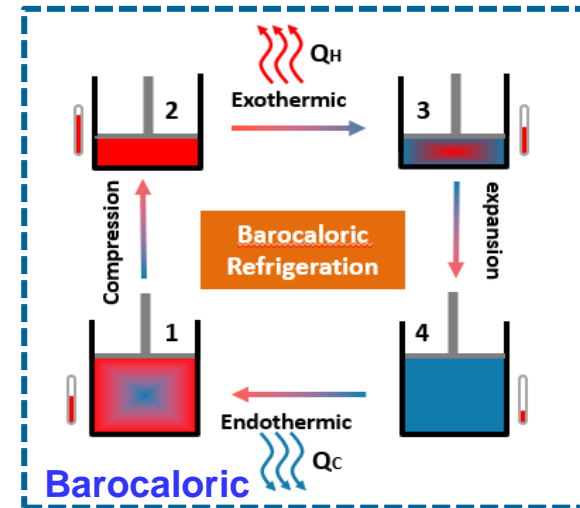
Magnetocaloric



Elastocaloric



Electrocaloric



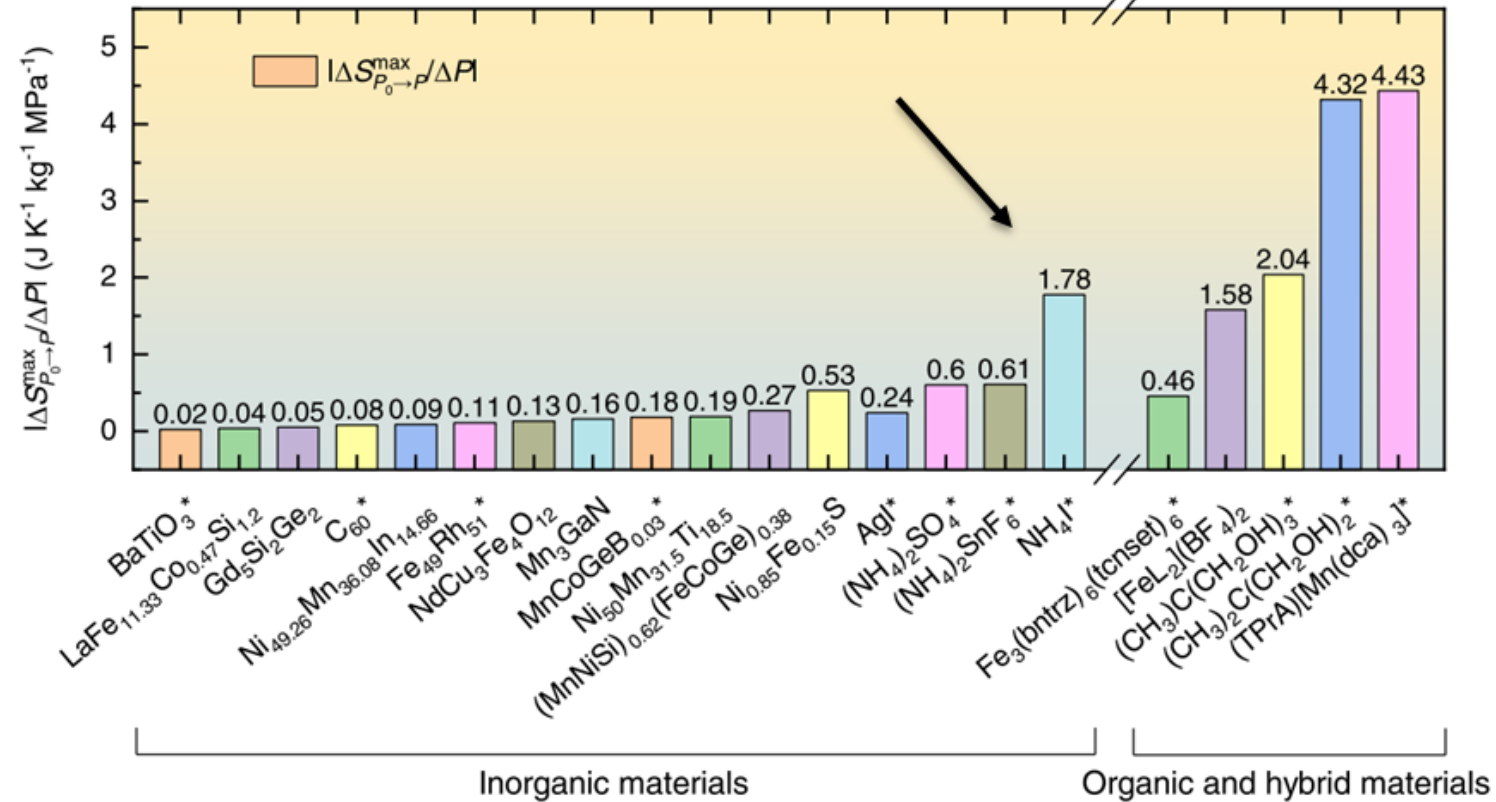
Barocaloric

Ren et al. (2022) Nature Communications, 13, 2293; Dai et al (2023) Advanced Functional Materials, <https://doi.org/10.1002/adfm.202307822>

Challenges: (a) how to engineer materials to achieve cold production at a right temperature range for data centre cooling $\sim 6-11^\circ\text{C}$; (b) how to translate the materials scale performance to device and system level performance; and (c) how to scale up the process and equipment?

Material developments: barocaloric inorganic compound

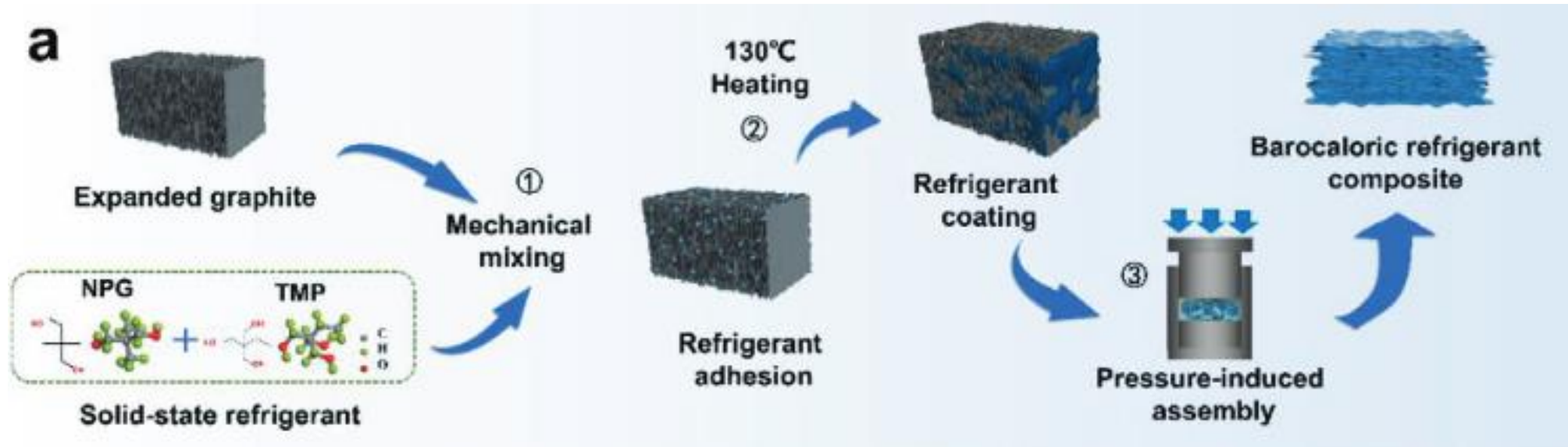
- Ren et al. (2022) performed a thorough study on the inorganic compound NH_4I which exhibits a **giant barocaloric effect** over a broad temperature range
- Results show potential for **efficient and affordable** barocaloric refrigeration



Ren Q, et al. Ultrasensitive barocaloric material for room-temperature solid-state refrigeration. Nature Communications 2022; 13: 2293. <https://doi.org/10.1038/s41467-022-29997-9>

Material developments: new barocaloric composite

- Dai et al. (2023) recently developed a molecular design strategy for novel plastic crystals, showing the potential for composite barocaloric materials in practical applications



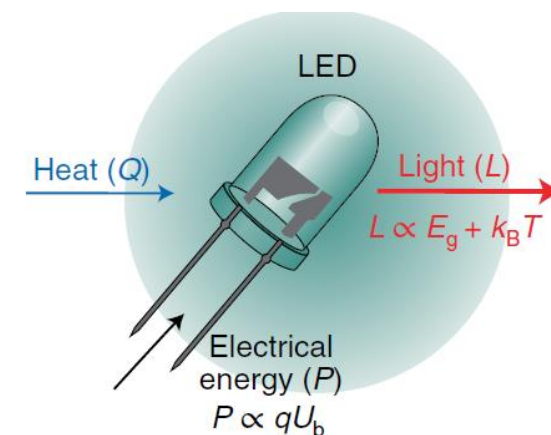
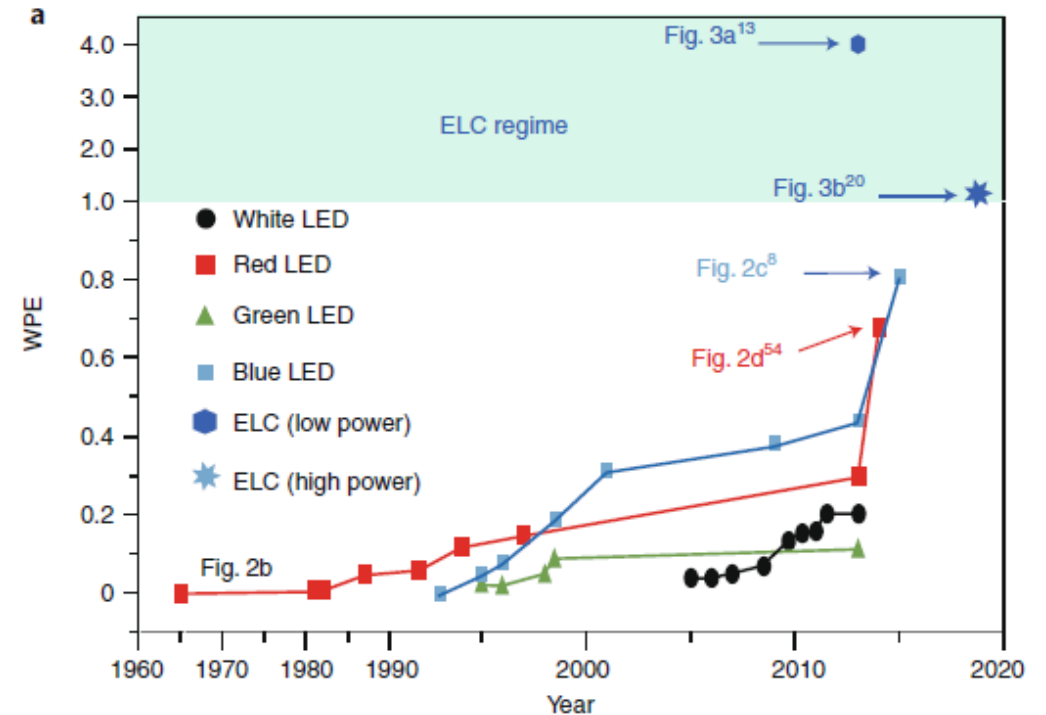
Dai Z, et al Synergistic advancement of molecular design and dual encapsulation technology for high-performance room-temperature barocaloric refrigeration materials. *Advanced Functional Materials* 2023; 2307822.

<https://doi.org/10.1002/adfm.202307822>

Thermophotonic cooling

- Light-emitting diodes could be more than simple electricity-to-light converters, as they are solid-state thermodynamic machines [19]
- High material quality requirements are needed, but recent advances and available experimental data in **electroluminescent cooling by LEDs** suggest practical cooling could be feasible

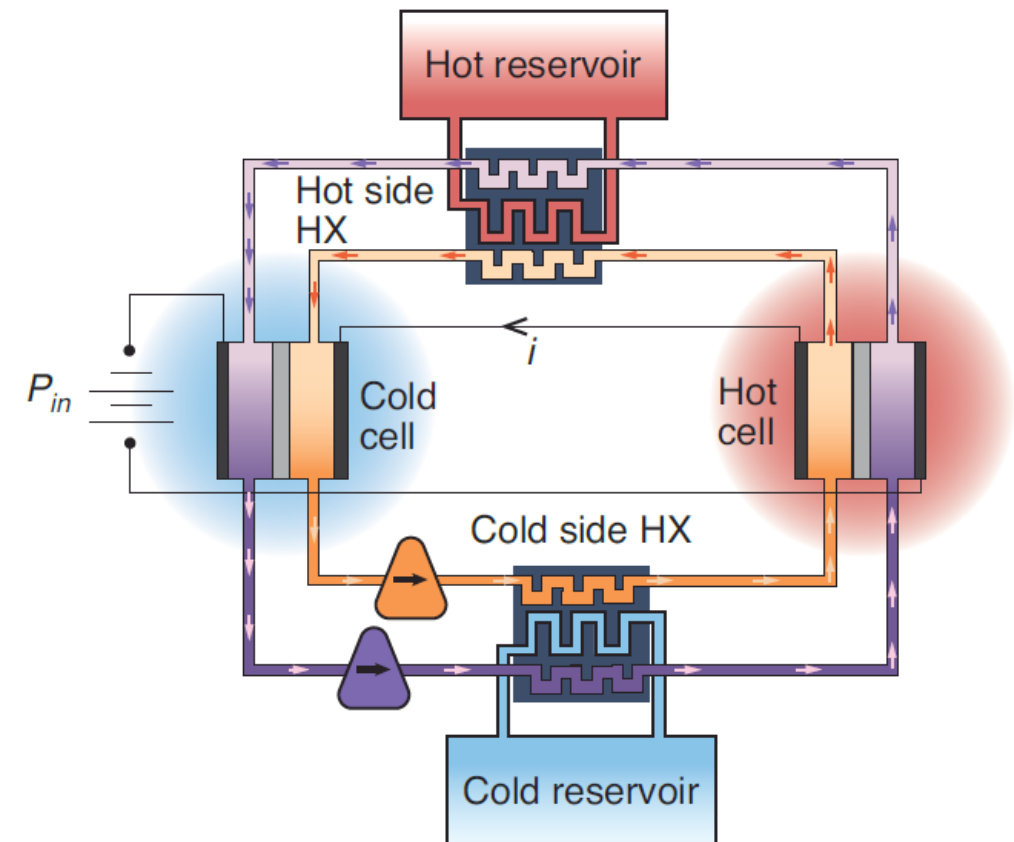
Sadi T, Radevici I, Oksanen J. Thermophotonic cooling with light-emitting diodes. Nature Photonics 2020; 14: 205-214.
<https://doi.org/10.1038/s41566-020-0600-6>.



Brayton electrochemical refrigerator (BECR)

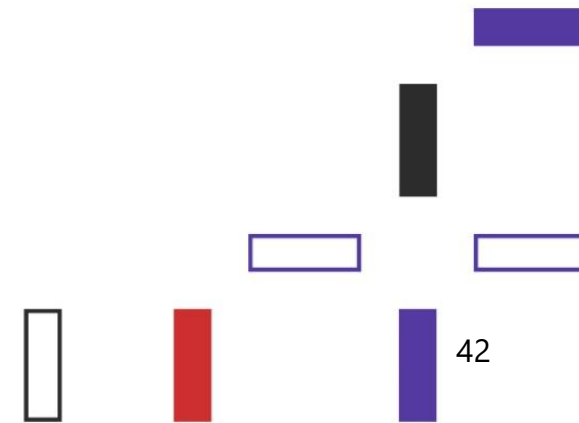


- Rajan et al. (2022) developed a system which uses the **thermogalvanic effect** of two electrochemical cells — one 'hot' and one 'cold' — and two different redox electrolytes to build a cooling cycle
- **Promising efficiency and potential for cold storage**
- Just as flow batteries can store electrical energy in electrolyte tanks, BECRs can store heat and cold in **insulated electrolyte tanks**



Key remarks

- Data centres cooling: combination of **efficiency, reliability, safety**
- Need to explore: soft faults detection, modularity, maintenance (drones?)
- Need for fundamental and applied science: computational materials, functionalized materials, thermophotonics, biomimics, etc
- Systems integration opportunities (natural resources, storage, cryogenics)
- Regulatory and voluntary schemes in EU to improve energy efficiency at the component level such as ENERGY STAR and EU Ecodesign Regulations for servers and data storage products





Backing visionary entrepreneurs

Thank you!

*Antonio Marco Pantaleo
Programme manager energy and green tech
Denver, 19 October 2023*

European
Innovation
Council



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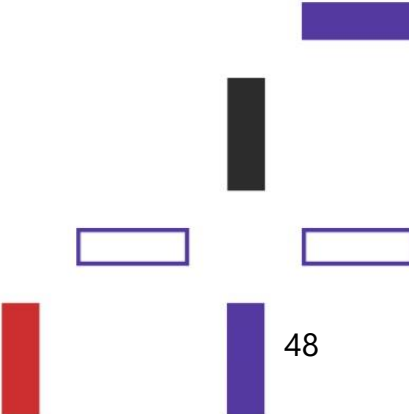
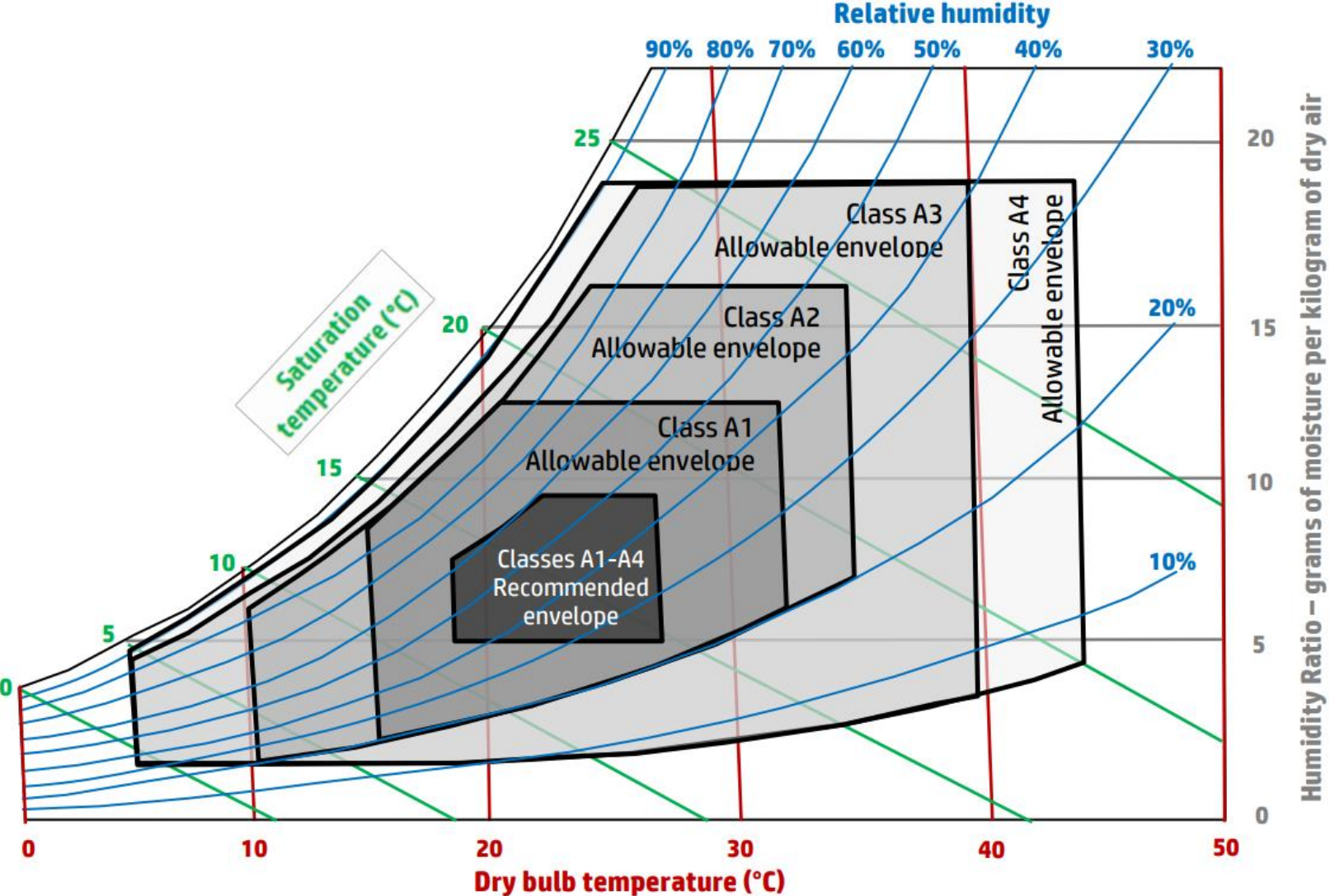


ASHRAE thermal guidelines

- Data centres are categorised according to environmental requirement levels [5]

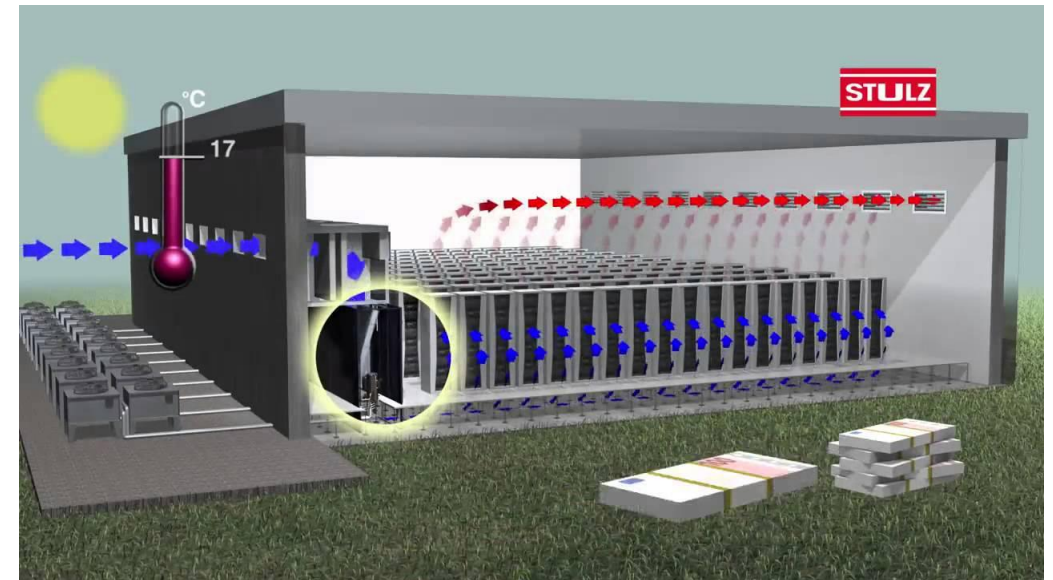
Class ^a	Equipment Environmental Specifications for Air Cooling						
	Product Operations ^{b,c}					Product Power Off ^{c,d}	
	Dry-Bulb Temperature ^{e,g} °C	Humidity Range, Non-Condensing ^{h,i,k,l}	Maximum Dew Point ^k °C	Maximum Elevation ^{e,i,j,m} m	Maximum Temperature Change ^f in an Hour (°C)	Dry-Bulb Temperature °C	Relative Humidity ^k %
Recommended (Suitable for all 4 classes)							
A1	15 to 32	-12°C DP & 8% RH to 17°C DP and 80% RH ^k	17	3050	5/20	5 to 45	8 to 80
A2	10 to 35	-12°C DP & 8% RH to 21°C DP and 80% RH ^k	21	3050	5/20	5 to 45	8 to 80
A3	5 to 40	-12°C DP & 8% RH to 24°C DP and 85% RH ^k	24	3050	5/20	5 to 45	8 to 80
A4	5 to 45	-12°C DP & 8% RH to 24°C DP and 90% RH ^k	24	3050	5/20	5 to 45	8 to 80

Recommended envelopes



Free cooling

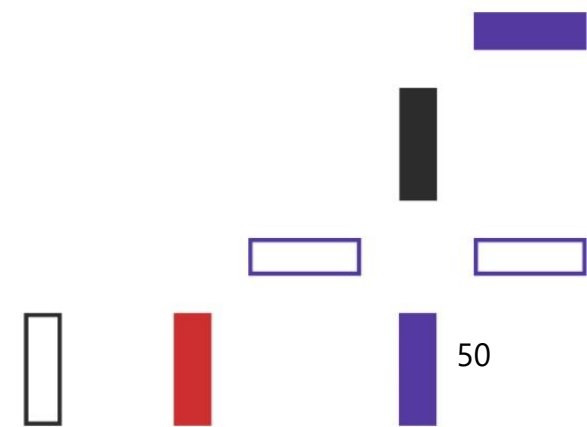
- Air-side: **Ambient air** is used to cool down the data centre
- Water-side: **Nearby water** source is used to cool down the data centre
- Free cooling is location-specific
- Humidity control still required



STULZ DFC² Direct Free Cooling [6]



Research organisations and patents





Research centres working on data centre cooling

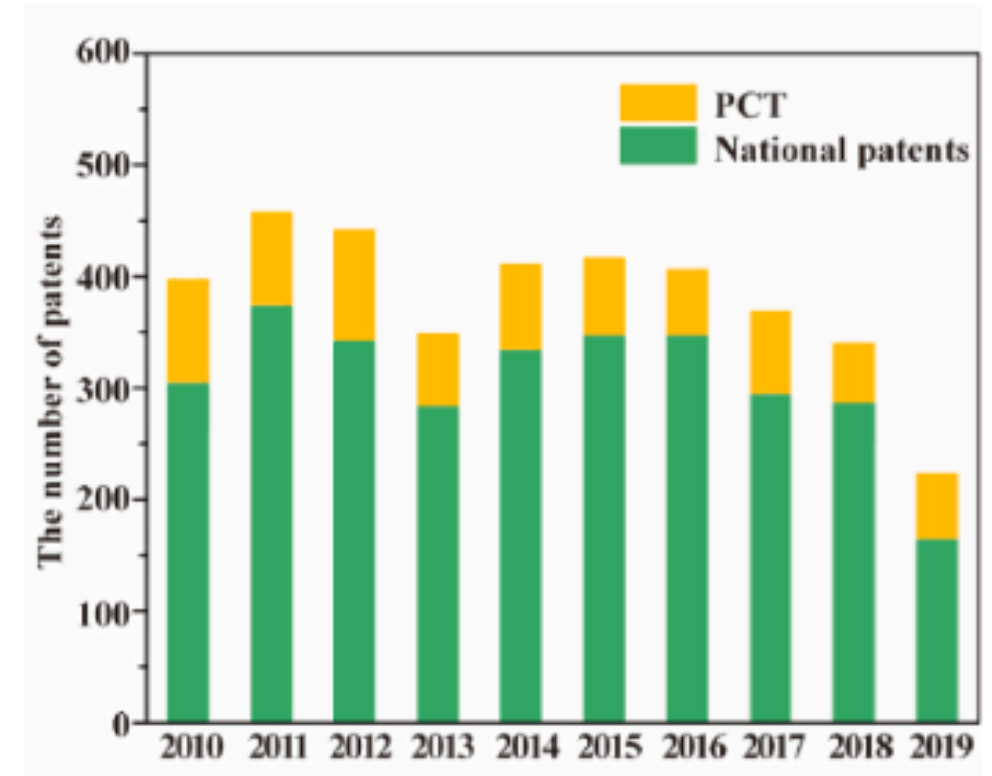
- Hundreds of papers every year
- Zhang et al.[4] compiled data on the top 10 research organisations working on cooling

Top 10 research organisation working on cooling technologies for DCs and TBSs.

Research institutions	Number of publications (2010–2019)
Chinese Academy Of Sciences	188
University Of California System	154
Centre National De La Recherche Scientifique	116
Max Planck Society	84
Tsinghua University	77
Massachusetts Institute Of Technology	74
Georgia Institute Of Technology	72
Russian Academy Of Sciences	69
University Of Michigan System	63
University Of Cambridge	61

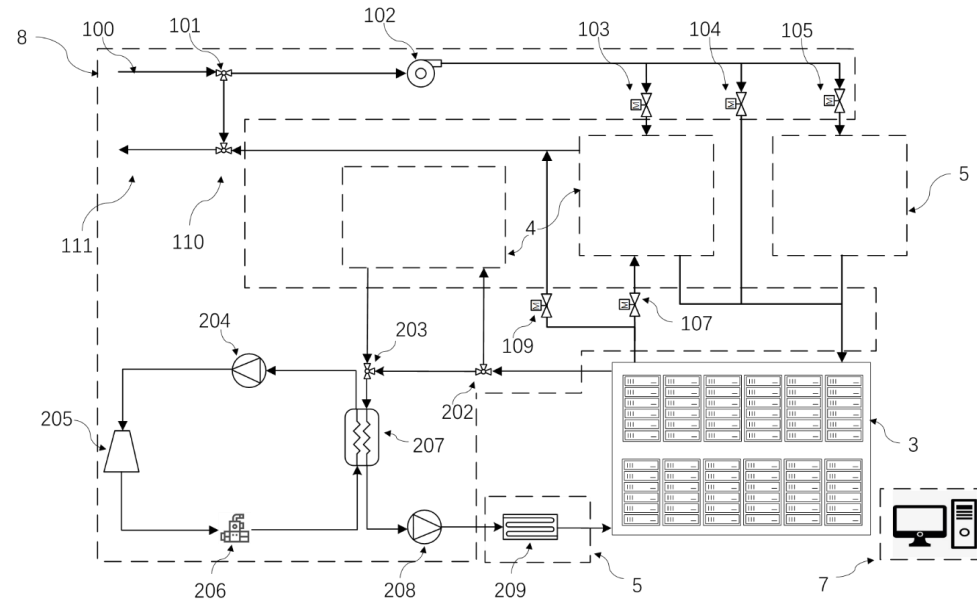
Granted patent examples

- US11076508B2: Cooling systems for **immersion cooled IT equipment**, 2021
- US11240938B2: **Evaporative induction** cooling system for a data center, 2022.
- US20210396422A1: Using **liquid to air membrane energy exchanger** for liquid cooling, 2021.
- US11503744B2: Methods and systems for **managing facility** power and cooling, 2022.



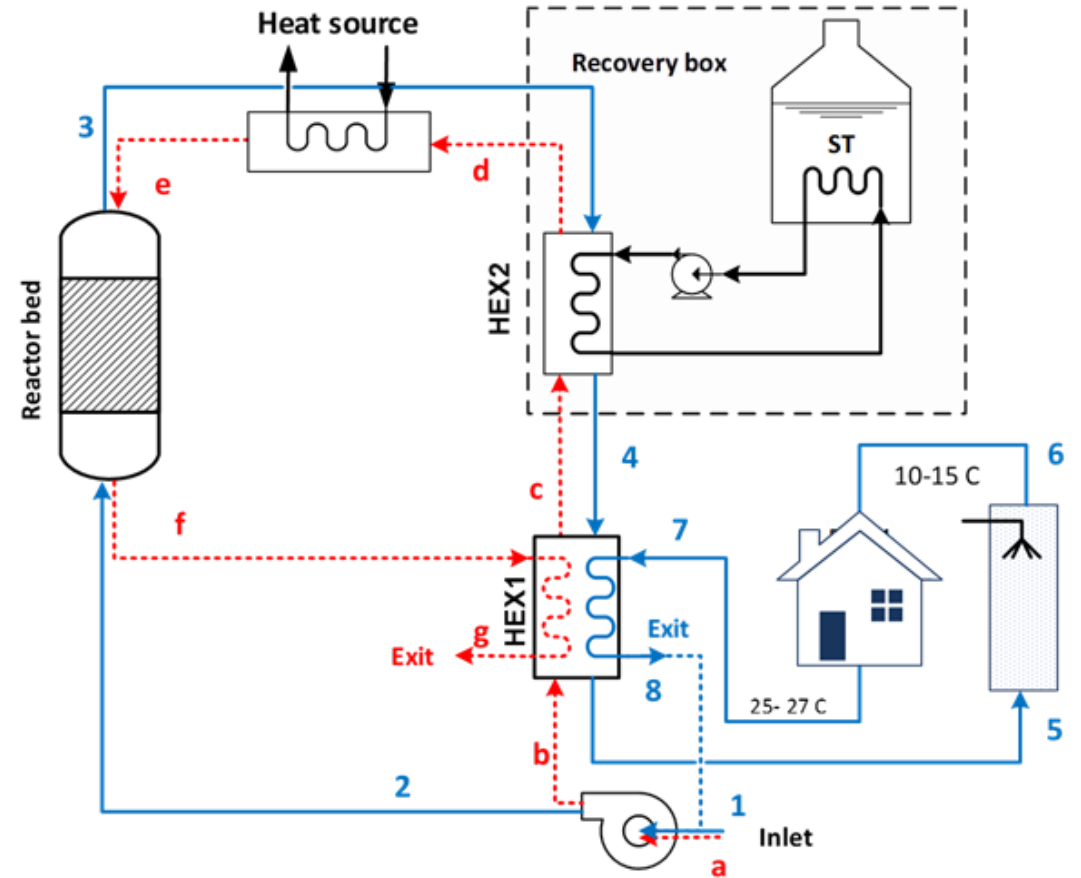
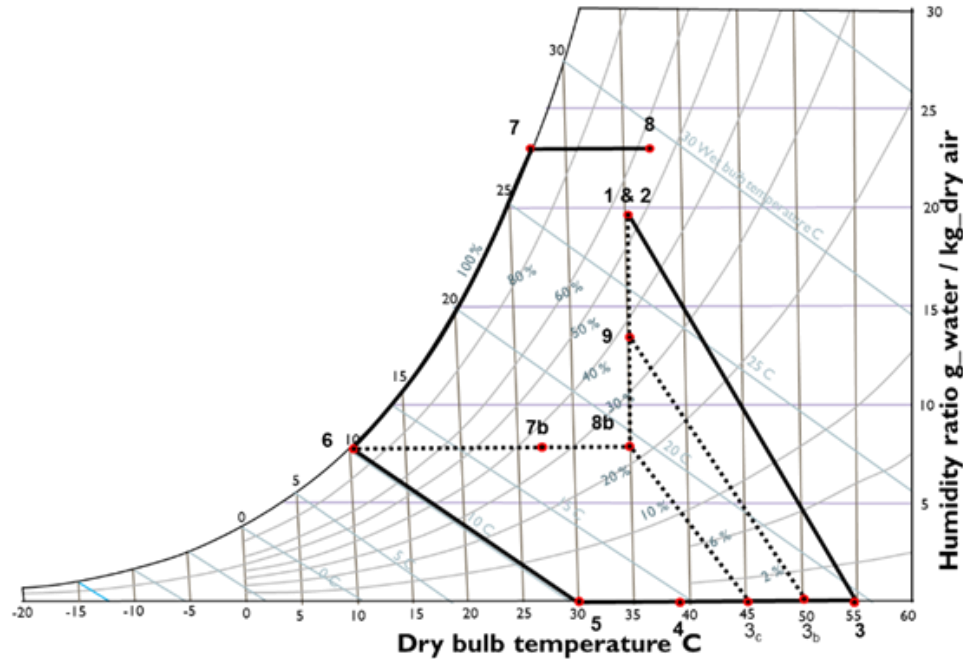
Significant improvement of current cold production technologies

Methods: (a) reduction of energy consumption of compressors; (b) effective use of waste heat from data-centres; (c) effective use of natural energy



Challenges: (a) how to use cold energy storage, e.g. PCM, to deal with peak cooling demand, so that the the power rating of compressors can be reduced substantially? (b) how to use the low-grade heat from data centres to produce cold? (c) how to design the whole cooling system so that natural cold energy can be used in a cost-effective way?

Cold production & storage: Thermochemical based cold production



Challenges: (a) how to use data-centre waste heat to drive thermochemical based cold production system? (b) how to enhance thermochemical material's performance (heat and mass transfer, reaction kinetics, life-span)? (c) how to scale up the process and equipment?